# HITACHI MICROCOMPUTER SYSTEM HMCS6800 



CMOS 8-BIT SINGLE CHIP MICROCOMPUTER UNIT(MCU) HD63L05 USER'S MANUAL

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HD63L05
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PRELIMINARY

Examples of circuit and examples of characteristics described in this manual are designed to explain typical application examples of the Hitachi Semiconductors.

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The HD63LO5 is a 3 V CMOS single-chip microcomputer for battery-operated systems with the same instruction set as the HD6805S and abundant on-chip functions with extremely low power consumption.

The HD63L05 has architecture that is suitable for the controller field in which bit input / output and status flag processing on software are important and it also includes the LCD drivers, analog-to-digital converter, etc. which are effective in the reduction of the number of system parts.

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## 1. General

### 1.1 Features of the HD63LO5

The HD63L05 is a 3V CMOS single-chip microcomputer for battery-operated systems with the same instruction set as the HD6805S and abundant on chip functions with extremely low power consumption.

This microcomputer operates from a $3 V$ power supply with extremely low power consumption and has two lower power consumption mode; a softwarecontrolled halt mode and a standby mode. which is controlled through the input terminal.

The HD63LO5 contains two on chip oscillators, an 8-bit timer with a programmable 7 -bit prescaler, 20 input/output ports, 4 kbyte ROMs, 96 byte RAMs, LCD drivers and an 8-bit analog-to-digital converter. Due to the maskoption, the functions of the limited terminals are substitutable by other functions such as LCD drivers, analog inputs, or digital outputs.

The HD63LO5 instruction set is compatible with Hitachi's NMOS 8-bit single-chip microcomputer HD6805S in the operation code level. The processor keeps the advanced features of the HD6805 family's instruction set, such as powerful bit manipulation.

Table 1-1 Features of the HD63L05


## Package



FP-80

* DP-64S,FP-64 are under development.


### 1.2 Design Procedure and Supporting Tool

The cross assembler and the hardware simulator using various types of computer are prepared by the company as supporting systems to develop users' programs.

Users' programs are mask programed into the ROM and delivered as the LSI by the company.

Fig.1-1 shows the typical program design procedure and Table 1-2 shows the system development supporting tool for the HD63L05 which are used in these processes.


Figure 1-1 Program Design Procedure

Table 1-2 System Development Supporting Tool

| Type Name | Resident System |  | Cross System |
| :---: | :---: | :---: | :---: |
|  | Evaluation Kit | Evaluation Board |  |
| HD63L05F1 | H3L5EVT1 <br> (Hardware) <br> + |  | Emulator for SD5 |
|  | S3L5MIX1-R <br> (Software) | H3L5EV00 | Cross assembler editor <br> for SD5/10/15/20 |
|  |  | Cross assembler editor <br> for Intel MDS |  |

Input signals and output signals of the MCU are described below.

- Vcc, Vss
power is supplied to the MCU by using these two terminals. Vcc has a voltage of $3.0 \mathrm{~V} \pm 0.8 \mathrm{~V}$, and Vss is grounded.
- $\overline{\text { INT }}$

This terminal is used to enboke an external interruption to the MCU. See Section "2.8Interrupts" for details.

- XTAL, EXTAL

These terminals are control input terminals to the built-in clock circuit. A crystal ( 400 kHz typ.) or a resister is connected to these terminals in accordance with stability of internal oscillation. See Section" 2.7 Internal Oscillator Options" for how to use these terminals.

TIMER
This terminal is an external input terminal to count down the internal timer circuit. See " 2.4 Timer" for the detailed description of the timer circuit.
$\overline{\text { RES }}$
Used to reset the MCU. See " 2.5 Resets" for details.
STANDBY
An external input terminal used to stop the MCU and hold data. For details, see " 2.7 Internal Oscillator Options".

- A/D Input Terminals (CH1~CH8)

Input terminals for analog voltages needed for $A / D$ conversion. These may also be used as level check inputs under program control. See "2.10A/D Converter" for details.

- VRH, VRL

Reference voltages for $A / D$ conversion are applied to these two terminals. For details, see '2.10A/D Converter".

- CC1, CC2

An offset compensating capacitor ( 300 pF typ.) is connected between CC1 and CC2. For details, see "2.10A/D Converter".

- NUM

This terminal is not used for user application. Connect it to Vcc.

- Input/Output Terminals (A0 A7, B0 B7,CO C3)

These 20 terminals consist of two 8-bit ports and one 4-bit port. Each of them may be used as an input or output under program control of the data direction register. For details, see " 2.9 Input/Output".

- Liquid Crystal Driver Terminals (COM1~COM3, SEG1~SEG17)

COM1~COM3 are for driving common electrodes, while SEG1 SEG17 are for driving segments. SEG1~SEG17 can be used as outputs by mask-option and SEG13~SEG17 can be used as analog inputs for A/D converter by maskoption.

V1, V2
These are terminals for LCD driver. V1 and V2 are connected to Vcc via capacitors ( 0.1 uF each). These two terminals can be used as outputs or analog inputs by mask-option.

## - VCH

Output termianl from internal voltage regulator. A capacitor ( $0.5 \mu \mathrm{~F}$ ) is connected between VCH and Vci.
-
System clock output (cycle clock 100 kHz typ.)
This NMOS open-drain output stays at "Low" level when the MCU is in halt status or standby.

HD63L05 Block Diagram is shown in Figure 1-2.


Figure 1-2 HD63L05 Block Diagram

### 2.1 Memory

The MCU memory is configured as shown in Fig.2-1. During the processing of an interrupt, the contents of the MCU resisters are pushed onto the stack in the order shown in Fig.2-2. Since the stack pointer decrements during pushes, the low order byte (PCL) of the program counter is stacked first; then the high order four bits (PCH) are stacked. This ensures that the program counter is loaded correctly as the stack pointer increments when it pulls data from the stack. A subroutine call will cause only the program counter ( $\mathrm{PCH}, \mathrm{PCL}$ ) contents to be pushed onto the stack.

## Cautions

It is not possible to change the contents of the Write Only Register (For example, the Data Direction Register of the I/O port) of the HD63LO5 by applying the Read/Modify/Write instructions, BSET, or BCLR.

For preventing the system from wild running, don't address the Not Used area of the memory map.


Figure 2-1 Memory Map


Figure 2-2 Interrupt Stacking Order

### 2.2 Registers

The MCU has five registers available to the programmer. They are shown in Figure 2-3 and are explained in the following paragraphs.


Figure 2-3 Programming Model

Accumulator (A)
The accumulator is a general purpose 8 -bit register used to hold operands and results of arithmetic calculations or data manipulations.

Index Register (X)
The index register is an 8 -bit register used for the indexed addressing mode. It contains an 8 -bit address that may be added to an offset value to create an effective address. The index register can also be used for limited calculations and data manipulations when using read/ modify/write instructions. When not required by a code sequence being executed, the index register can be used as a temporary storage register.

Program Counter (PC)
The program counter is a 12 -bit register that contains the address of the next instruction to be executed.

Stack Pointer (SP)
The stack pointer is a 12 -bit register that contains the address of the next free location on the stack. Initially, the stack pointer is set to location $\$ 07 \mathrm{~F}$ and is decremented as data is being pushed onto the stack and incremented as data is being pulled from the stack. The most significant bits of the stack pointer are permanently set to 0000011 . During a MCU reset or the reset stack pointer (RSP) instruction, the stack pointer is set to location $\$ 07 \mathrm{~F}$. Subroutines and interrupts may be nested down to location $\$ 061$ which allows the programmer to use 15 levels of subroutine calls.
Condition Code Register (CC)
The condition code register is a 5-bit register in which each bit is used to indicate or flag the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state. Each individual condition code register bit is explained in the following paragraphs.

Half Carry (H)
Used during arithmetic operations ( ADD and ADC ) to indicate that a carry occurred between bit3 and bit4.

Interrupt (I)
This bit is set to mask the internal interrupts and external interrupt ( $\overline{\mathrm{INT}}$ ). If an interrupt occurs while this bit is set,it is latched and will be processed as soon as the interrupt bit is reset.
Note
CLI (clear interrupt mask bit) is used to allow the interruption from the instruction after next. SEI(set interrupt mask bit) masks the interruption from next instruction.

Negative (N)
Used to indicate that the result of the last arithmetic, logical of data manipulation was negative (bit7 in result equal to logical one).

Zero (Z)
Used to indicate that the result of the last arithmetic, logical of data manipulation was zero.

Carry/Borrow (C)
Used to indicate that a carry or borrow out of the arithmetic logic unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch insuructions, shifts, and rotates.

### 2.3 System Control Register

Apart from the registers for program operation explained above, there is a register that controls system operation. Its configuration is shown in Figure 2-4.

- Time Base Instruction Request Flag (TB INT)

Stores an interruption request from the time base which is selected by the TB select bit and is cleared by system reset or by program. If the TB MASK bit or I ( Interrupt bit in the CCR ) is set, the interruption request is not acknowledged. Only logical "0" can be written into this bit by program.

- Time Base Instruction Mask (TB MASK)

If this bit is set, any interrupt request from the time base is not acknowledged.

- Time Base Select Bit (TB SELECT)

This bit selects the time base. In logical "1", an interruption from the 1 -second cycle time base is acknowledged. In logical " 0 ", 1/16 second cycle time base is acknowledged.

- Time Base Reset Bit (TB RESET)

This bit resets the frequency divider behind the 32 kHz oscillator. When this bit is set, one shot reset pulse is generated by the hardware. Then it resets the frequency divider and after that, the frequency divider restarts. As this bit has not a register, the CPU always reads this bit as logical " 0 ". The frequency divider also provides the system clocks to the A/D converter and LCD drivers. So, it is needed to pay an attention when "TB RESET" is used.

- Halt (HALT)

Used to halt the CPU. When this bit is set, the registers are saved onto the stack in the same sequence as interruption processing. After all registers have been saved, the CPU halts and is wait-for-interrupt state.
If this bit is reset by an external interruption or an internal interruption, the CPU restarts operating. By using the Halt function with Time Base Interruption, the CPU can operate intermittently itself.

## - EXT

When the form of output port is selected by DUTY selecting bit, \$WRITE can be got every time data is written into LCD register in the case that this bit is "1". фWRITE can be used with the designation of pin location as the clock for writing in the case of transferring data of LCD register to the outside. Normally, EXT is reset.

Duty Select Bit (DUTY)
The LCD drive signal is based on $1 / 3$ bias - $1 / 3$ duty. However, there are switching circuits built in for static drive signal and output ports. For details, see the information given in "LCD Circuit".

Note : The EXT bit and the DUTY bits have to be initiallized in a 1 m second from the beginning of the system reset when the static drive signal or output port is selected.


Figure 2-4 System Control Register Configuration

### 2.4 Timer

The MCU timer circuitry is shown in Figure 2-5. The 8-bit counter is loaded under program control and counts down toward zero as soon as the colck input is applied. When the timer reaches zero the timer interrupt request bit (bit 7) in the timer control register is set. The MCU responds to this interrupt by saving the present MCU state in the stack, fetching the timer interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine. The timer interrupt can be masked by setting the timer interrupt mask bit (bit 6) in the timer control register. The interrupt bit ( $I$ bit) in the condition code register will also prevent a timer interrupt from being processed.

The clock input to the timer can be from an external source applied to the TIMER input pin or it can be the internal signal ( $\phi_{2}$ or $\phi_{3}{ }_{2} k$ ). When the internal clock signal is used as the source, the clock input is gated by the input applied to the timer input terminal; this permits easy measurement of its pulse width. There are two types of internal clock signals ( $\phi_{2}$ and $\phi_{32 k}$ ) to allow timer operation when the CPU is halted. ( $\phi_{2}$ is active when OSC1 is not stopped. ) These clock signals are under program control. Note that the timer operation is asynchronous to the CPU when the clock signal is from external source or $\phi_{32} k$.

A 7-bit prescaler is provided to extend the timing interval up to a maximam of 128 counts before being applied to the timer. The number of prescaling counts can be program controlled by the lower 3 bits within the timer control register. The timer continues to count past zero and its present count can be monitored at any time by monitoring the timer data register. This allows a program to determine the length of time since a timer interrupt has occurred and not disturb the counting process.

At the time of resetting, the prescaler and the counter are all initialized to logical "1". The timer interruption request bit is cleared and the timer interruption mask bit is set. The timer interrupt request bit ( bit 7 of Timer Control Register ) is set to logical "1" when timer count reaches zero, and is cleared by program or by system reset. Only logical " 0 " can be written into this bit by program. The bit 6 of Timer Control Register is writable by program. Both of these bits can be read by CPU.

### 2.5 Resets

The MCU can be reset either by initial powerup or by the external reset input ( $\overline{\mathrm{KES}}$ ). All the I/O ports are initialized to Input mode (DDRs are cleared) during RESET.

Upon power up, a minimum of 150 milliseconds is needed before allowing the reset input to go "High". This time allows the internal oscillator (OSC1) to stabilize. Connecting a capacitor to the RES input as shown in Fig. 2-8 will provide sufficient delay.

### 2.6 Self Check

The self check capability of the MCU provides an internal check to determine if the port is functional. Connect the MCU as shown in Figure 2-9 and monitor the output of port $C$ bit 3 for an oscillation of approximately 0.5 Hz . This self check capabibity also provides the internal state of the MCU to measure the LSI current. After a system reset, the MCU goes into each current measurement mode by the combination of the control switches. The LSI current can be measured when the NUM is returned to Vcc after setting of the current mode.


Figure 2-5 Timer Block Diagram


Figure 2-6 Timer Control Register Configuration


Figure 2-7 Power and Rest Timing

Figure 2-8
Input Reset Delay Circuit


Figure 2-9 Self Check Connections

### 2.7 Internal Oscillator Options

The MCU incorporates two oscillators : oscillator 1 for system clock supply and oscillator 2 for time base, analog to digital converter, and LCD drivers.

C Oscillator 1 ( OSC1; XTAL, EXTAL )
The internal oscillator circuit can be driven by an external crystal or resistor depending on the stability. A manufacturing mask option is avilable to provide better matching between the external components and the internal oscillator. The oscillator 1 can stop when power is applied in either Halt or Standby status. Figure 2-10 shows the connection. A resistor selection graph is given in Figure 2-11.

6 Oscillator 2 ( OSC2; XIN, XOUT )
Clocks for time base, LCD drivers, an analog-to-digital converter, and a timer can be supplied by the OSC2 ( 32.768 kHz crystal ) or by the OSC1 through the frequency divider. In Halt status, oscillator 2 operates and permits the operation of the peripheral modules with low power consumption. In Standby status, this oscillator stops when power is applied. Fugure $2-12$ shows the connection and the relation between oscillator 1 and oscillator 2 is shown Figure 2-13 and Figure 2-14.

Note
When OSC2 is not available or OSC1 is the crystal option, OSC1 is not allowed to stop at Halt. The accuracy of the time base is kept when OSC2 is 32.768 kHz crystal oscillator.


Figure 2- 10 Mask Option for Oscillator 1


Figure 2-11 Typical Resistor Selection Graph


Crystal Oscillator


Not Used


Figure 2-13 Relation between Oscillator1 and Oscillator2

Figure 2-12 Connection of Oscillator2

| Mask Option | When OSC1 is X-TAL |  |  |  |  |  | When OSC1 is RC |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | OSC2 <br> Not Available |  |  | OSC2 <br> Available |  |  | OSC2Not Available |  |  | OSC2 <br> Available |  |  |
| System <br> State | OSC1 | CPU | Peripheral | OSC1 | CPU | Peripheral | OSC1 | CPU | Peripheral | OSC1 | CPU | Peripheral |
| During System Operation | $\bigcirc$ | O | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ | 0 | O | $\bigcirc$ | $\bigcirc$ | $\bigcirc$ |
| At Halt | $\bigcirc$ | X | $\bigcirc$ | $\bigcirc$ | X | $\bigcirc$ | $\bigcirc$ | X | $\bigcirc$ | X | X | $\bigcirc$ |
| At Standby | X | X | X | X | X | $\times$ | X | X | X | X | X | X |

Figure 2-14 Oscillator2 Mask-option and System Operation

### 2.8 Interrupts

There are six different interruptions to the MCU : external interruption via external interrupt terminal (INT), internal timer interruption, interruption by termination of $A / D$ conversion, time base interruption (2 types), and software interruption by an instruction (SWI).

When any interrupt occurs, processing is suspended, the present MCU state is pushed onto the stack, the interrupt bit (I) in the condition code register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed. The interrupt service routines normally end with a return from interrupt instruction (RTI) which allows the MCU to resume processing of the program prior to the interrupt. Table $2-1$ provides a listing of the interrupts; their priority, and the vector address that contains the starting address of the appropriate interrupt routine.

Figure 2-15 shows the system operation flow, in which the portion surrounded with dot-dash lined contains interruption execution sequence.

Note : A clear interrupt bit instruction (CLI) allows to suspend the processing of the program by an interruption after execution of the next instruction while a set interrupt bit instruction (SEI) inhibits any interrupts before execution of the next instruction. When a mask bit of a control register is cleared by an instruction, interruption is allowed before execution of the next instruction.

- Acknowledging interrupts in HALT Status In HALT status, the CPU is stopped but the peripherals are operating. When an interrupt is acknowledged, the CPU is activated and executes interruption service matching the interruption condition by means of vectoring.
- Acknowledging interrupts in Standby Status In Standby status, the system is all stopped with power supplied to it. Therefore, any interruption request ( including $\overline{\mathrm{RES}}$ ) is not acknowledged.

Table 2-1 Interruption Priority

| Interruption | Priority | Vector Address |
| :--- | :---: | :---: |
| $\overline{\text { RES }}$ | 1 | \$FFFE, \$FFFF |
| SWI | 2 | \$FFFC, \$FFFD |
| $\overline{\text { INT }}$ | 3 | \$FFFA, \$FFFB |
| TIMER | 4 | \$FFF8, \$FFF9 |
| A/D | 5 | \$FFF6, \$FFF7 |
| TIME BASE | 6 | \$FFF4, \$FFF5 |



Figure 2-15 System Operation Flowchart

### 2.9 Input/Output ( Port A,B,C )

There are 20 input/output terminals. All pins are programmable as either inputs or outputs under software control of the data direction register. When programmed as outputs, all $\mathrm{I} / 0$ pins read latched output data regardless of the logic level at the output pin due to output pin due to output loading ( see Figure 2-16).

Manufacturing mask-options are available to provide better matching between the external components and the $I / 0$ ports. Figure $2-17$ shows the configuration of $I / O$ ports. As the output is on/off controlled by a data direction register, an $1 / 0$ port may directly be applied as an input terminal. No problem is involved with the input if both "High" and "Low" levels are applied. For one level input, the user must specify the use of a pull-up PMOS for "Open/Low" input application.

Two types of the output PMOS drivability ( $I_{0 H}=-100 \mu \mathrm{~A}$ or $\mathrm{I}_{\mathrm{OH}}=-10 \mu \mathrm{~A}$ ) or NMOS open drain can be selected by mask option for output application All $\mathrm{I} / 0$ Pins are initialized as inputs by system reset.

### 2.10 A/D Converter

The MCU incorporates an 8 bits A/D converter based on the resistor ladder system. Figure 2-18 shows its block diagram.

The "High" side of reference voltage is applied to $\mathrm{V}_{\mathrm{RH}}$, while the "Low" side of reference voltage is applied to VRL. The reference voltage is divided by resistors into voltages matching each bit, which is compared with analog input voltage for $A / D$ conversion. As the analog input voltage is applied to the MOS gate of the comparator through the analog multiplexer, this voltage comparison system achieves high input impedance. Offset of the comparator are compensated for each bit by external capacitor which is connected between CC1 and CC2.

The A/D DATA Register stores the results of an A/D conversion or can be set 8 bit data for programmed comparator. These functions are controlled by software-controlled A/D CTRL Register. Figure 2-19 shows the configuration of the $A / D$ control register.

- A/D INT

The A/D INT bit is set to logical "1" after completion of A/D conversion and is cleared by program or by system reset. Only logical " 0 " can be written into this bit by program.
-A/D MASK
If this bit is set, interrupt from the $A / D$ converter is not acknow1edged. This bit can be written by program.

- CNV

To start A/D conversion, set this bit to logical "1". During conversion, data of this bit stays at "1". The bit is automatically reset to " 0 " when the $A / D$ conversion ends. In $A / D$ conversion, supply voltage is applied to the comparator only when CNV="1". The digital data which is obtained by the $A / D$ conversion is held in the A/D data register. This data is reset when the CNV is set to "1" again.

- Auto/Program

Used to select either auto-run 8 bits A/D conversion or 8 bit programmed comparator operation (Auto 8 bits A/D conversion at "0").


Figure 2-16 Port I/O Circuit


Figure 2-17 Selection of the Input Configuration for I/O Port


Figure 2-18 8 Bits A/D Converter Block Diagram
7
$\left.\begin{array}{|c|c|c|c|c|ccc|}\hline \begin{array}{c}\text { A/D } \\ \text { INT }\end{array} & \begin{array}{c}\text { A/D } \\ \text { MASK }\end{array} & \text { CNV } & \frac{\text { Auto }}{\text { Program }} & \begin{array}{c}\text { COMP } \\ \text { OUT }\end{array} & & \text { MPX } & \\ \hline 10 & 1 & 0 & 0 & 1 & 0 & 0 & 0\end{array}\right)$ A/D CTRL.
Register

Figure 2-19 A/D Control Register Configuration

COMP OUT
The result of comparator operation under program control can be read from this bit ( Logical "1" means that input voltage is higher than programmed reference voltage ).

## - MPX

Used to select 8 -channel analog inputs. The multiplexer is $\because n$ analog switch based on CMOS. Note that the analog inputs from CH2 to CH8 are mask option which CH 1 is CH 7 and CH 8 are not available because these two terminals are used for LCD power supply.

### 2.11 LCD Circait

The system configuration of the LCD circuits is shown in Figure 2-20 Segment data for display are stored in data registers LCD1 to LCD8. Since the circuits are connected to the output terminals via pin location block, the user may specify a combination of data to be multiplexed to the segment output terminals.

The bit data of the LCD register is combined with the timing clock ( $\phi_{1}, \phi_{2}$ or $\phi_{3}$ ) and three combined bit data are gathered to make a segment output data for $1 / 3$ bias $-1 / 3$ duty driving in the pin location block. In case of static LCD drive of output port, timing is always fixed at $\phi_{1}$ (always "High") and one bit data of the LCD register is transferred for an output terminal.

Note that the output terminals from SEG13 to SFG17 are mask option while the others (SEG1 to SEG12) are always available when the Duty bits are "01" or "11".

When the form of output port is selected by Duty bit ("00"), $\phi$ WRITE can be got every time data is written into LCD1 register in the case that EXT bit is "1". As LCD1 register has 8 bits latches, it is easy to transfer the internal 8 bits data to external devices via output ports, with automatically generated write clock $\phi$ WRITE. The cycle clock pulse can be also available as an internal data source for the output terminal when output port is selected.

Assignment of segment terminals to the bits of the LCD data register, including the case where they are used as output terminals, is to be specified by the user when he orders masks.

### 2.12 Liquid Crystal Driver Wave Forms

The LCD circuit is based on $1 / 3$ bias $-1 / 3$ duty driving. Figure 2-21 shows the common electrode output signal waveforms ( COM1, COM2, COM3 ), segment signal waveforms ( SEG1 to SEG17) and LCD bias waveforms (between COM and SEGMENT ).


Figure 2-20 LCD Circuit System Configuration


Figure 2-21 LCD Driving Waveforms

The MCU has the ability to set or clear any single random access memory or input/output bit (except the data direction registers) with a single instruction (BSET, BCLR). Any bit in the page zero read only memoly can be tested, using the BRSET and BRCLR instructions, and the program branches as a result of its state. This capability to work with any bit in RAM, ROM or $I / 0$ allows the user to have individual flags in RAM or to handle single I/O bits as control lines.

NOTE
It is needed to pay attention to the system control register, the timer control register, and A/D control register when BSET,BCLR,or Read/Modify/Write instructions are applied to them. If own interrupt request occured onto the interrupt request bit (bit7) of the control register between read cycle and write cycle of these instructions, the bit7 might be cleared in the write cycle and not acknowledged by CPU.

The MCU has ten addressing modes available for use by the programmer. They are explained and illustrated briefly in the fillowing paragraphs.

## -Immediate

Refer to Figure2-22. The immediate addressing mode accesses constants which do not change during program execution. Such instructions are two bytes long. The effective address (EA) is the PC and the operand is fetched from the byte following the opcode.

## - Direct

Refer to Figure2-23. In direct addressing,the address of the operand is contained in the second byte of the instruction. Direct addressing allows the user to directly address the lowest 256 bytes in memory. A11 RAM space, I/O registers and 128 bytes of ROM are located in page zero to take advantage of this efficient memory addressing.

## - Extended

Refer to Figure 2-24 . Extended addressing is used to reference any location in memory space. The EA is the contents of the two byte following the opcode.Extended addressing instructions are three bytes long.

## -Relative

Refer to Figure 2-25. The relative addressing mode applies only to the branch instructions. In this mode the contents of the byte following the opcode is added to the program counter when the branch is taken. $E A=(P C)+2+R e l . R e l$ is the contents of the location following the instruction opcode with bit 7 being the sign bit. If the branch is not taken, Rel $=0$. When a branch takes place, the program goes to somewhere within the range of +129 bytes to -127 of the present instruction. These instructions are two bytes long.

- Indexed (No Offset)

Refer to Figure 2-26. This mode of addressing accesses the lowest 256 bytes of memory. These instructions are one byte long and their EA is the contents of the index register.

- Indexed (8-bit Offset)

Refer to Figure 2-27. The EA is calculated by adding the contents of the byte following the opcode to the contents of the index register. In this mode, 511 lowest memory locations are accessable. These instructions occupy two bytes.

- Indexed (16-bit Offset)

Refer to Figure 2-28 . This addressing mode calculates the EA by adding the contents of two bytes following the opcode to the index register. Thus, the entire memory space may be accessed. Instructions which use this addressing mode are three bytes long.

- Bit Set/Bit Clear

Refer to Figure 2-29. This mode of addressing applies to instructions which can set or clear any bit on page zero. The lower three bits in the opcode specify the bit to be set or cleared while the byte following the opcode specifies the addresss in page zero.
-Bit Test and Branch
Refer to Figure 2-30 . This mode of addressing applies to instructios which can test any bit in first 256 locations ( $\$ 00-\$ F F$ ) and branch to any location relative to the PC. The byte to be tested is addressed by the byte following the opcode. The individual bit within that byte to be tested is addressed by the lower three bits of the opcode. The The third byte is the relative address to be added to the program counter if the branch condition is met. These instructions are three bytes long. The value of the bit tested is written to the carry bit in the condition code register.

- Implied

Refer to Figure 2-31. The implied mode of addressing has no EA. All the information necessary to execute an instruction is contained in the opcode. Direct operations on accumulator and the index register are included in this mode of addressing. In addition, contril instructions such as SWI,RTI belong to this group. All implied addressing instructions are one byte long.

### 2.15 Instruction Set

The MCU has a set of 59 basic instructions. They can be divided into five different types: register/memory, read/modify/write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

- Register/Memory Instructions

Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtained from memory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to Table 2-2.

- Read/Modify/Write Instructions

These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register. The test for negative or zero (TST) instruction is an exception to the read/modify/ write instructions since it does not perform the write. Refer to Table 2-3.

- Branch Instructions

The branch instructions cause a branch from the program when a certain condition is met. Refer to Table 2-4.

Bit Manipulation Instructions
These instructions are used on any bit in the first 256 bytes of the memory. One group either sets or clears. The other group performs the bit test and branch operations. Refer to Table 2-5.

- Control Instructions

The control instructions control the MCU operations during program execution. Refer to Table 2-6.

Alphabetical Listing
The complete instruction set is given in alphabetical order in Table 2-7.
Opcode Map
Table 2-8 is an opcode map for the instructions used on the MCU.


Figure 2-22 Immediate Addressing Example


Figure 2-23 Direct Addressing Example


Figure 2-24 Extended Addressing Example


Figure 2-25 Relative Addressing Example


Figure 2-26 Indexed (No Offset) Addressing Example


Figure 2-27 Indexed (8-Bit Offset) Addressing Example


Figure 2-28 Indexed (16-Bit Offset) Addressing Example


Figure 2-29 Bit Set/Clear Addressing Example


Figure 2-30 Bit Test and Branch Addressing Example


Figure 2-31 Implied Addressing Example

Table 2-2 Register/Memory Instructions

|  |  | Addressing Mode |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Immediate |  |  | Direct |  |  | Extended |  |  | Indexed (No Offset) |  |  | Indexed(8-Bit Offset) |  |  | Indexed (16-Bit Offset) |  |  |
| Operation | Mnemonic | $\begin{aligned} & \text { Op } \\ & \text { Code } \end{aligned}$ | $\begin{array}{\|c\|} \hline \# \\ \text { Bytes } \\ \hline \end{array}$ | $\begin{gathered} \text { \# } \\ \text { Cycles } \end{gathered}$ | $\begin{array}{\|c} \hline \mathrm{Op} \\ \text { Code } \end{array}$ | $\begin{array}{\|c} \# \\ \text { Bytes } \end{array}$ | Cycles | $\begin{gathered} \text { Op } \\ \text { Code } \end{gathered}$ | $\begin{array}{\|c\|} \hline \# \\ \text { Bytes } \\ \hline \end{array}$ | Cycles | $\begin{array}{\|c\|} \hline \text { Op } \\ \text { Code } \\ \hline \end{array}$ | $\begin{gathered} \# \\ \text { Bytes } \end{gathered}$ | Cycles | $\begin{array}{\|c\|} \hline \text { Op } \\ \text { Code } \end{array}$ | $\begin{gathered} \# \\ \text { Bytes } \end{gathered}$ | Cycles | $\begin{array}{\|c\|} \hline \text { Op } \\ \text { Code } \\ \hline \end{array}$ | $\begin{array}{\|c\|} \hline \# \\ \text { Bytes } \end{array}$ | $\begin{gathered} \# \\ \text { Cycles } \end{gathered}$ |
| Load A from Memory | LDA | A6 | 2 | 2 | B6 | 2 | 3 | C6 | 3 | 4 | F6 | 1 | 2 | E6 | 2 | 4 | D6 | 3 | 5 |
| Load X from Memory | LDX | AE | 2 | 2 | BE | 2 | 3 | CE | 3 | 4 | FE | 1 | 2 | EE | 2 | 4 | DE | 3 | 5 |
| Store A in Memory | STA | - | - | - | B7 | 2 | 4 | C7 | 3 | 5 | F7 | 1 | 3 | E7 | 2 | 5 | D7 | 3 | 6 |
| Store X in Memory | STX | - | - | - | BF | 2 | 4 | CF | 3 | 5 | FF | 1 | 3 | EF | 2 | 5 | DF | 3 | 6 |
| Add Memory to A | ADD | $A B$ | 2 | 2 | BB | 2 | 3 | CB | 3 | 4 | FB | 1 | 2 | EB | 2 | 4 | DB | 3 | 5 |
| Add Memory and Carry to A | ADC | A9 | 2 | 2 | 89 | 2 | 3 | C9 | 3 | 4 | F9 | 1 | 2 | E9 | 2 | 4 | D9 | 3 | 5 |
| Subtract Memory | SUB | AO | 2 | 2 | 80 | 2 | 3 | CO | 3 | 4 | FO | 1 | 2 | EO | 2 | 4 | D0 | 3 | 5 |
| Subtract Memory from A with Borrow | SBC | A2 | 2 | 2 | B2 | 2 | 3 | C2 | 3 | 4 | F2 | 1 | 2 | E2 | 2 | 4 | D2 | 3 | 5 |
| AND Memory to A | AND | A4 | 2 | 2 | B4 | 2 | 3 | C4 | 3 | 4 | F4 | 1 | 2 | E4 | 2 | 4 | D4 | 3 | 5 |
| OR Memory with $A$ | ORA | AA | 2 | 2 | BA | 2 | 3 | CA | 3 | 4 | FA | 1 | 2 | EA | 2 | 4 | DA | 3 | 5 |
| Exclusive OR Memory with A | EOR | A8 | 2 | 2 | B8 | 2 | 3 | C8 | 3 | 4 | F8 | 1 | 2 | E8 | 2 | 4 | D8 | 3 | 5 |
| Arithmetic Compare A with Memory | CMP | A1 | 2 | 2 | B1 | 2 | 3 | C1 | 3 | 4 | F1 | 1 | 2 | E1 | 2 | 4 | D1 | 3 | 5 |
| Arithmetic Compare X with Memory | CPX | A3 | 2 | 2 | B3 | 2 | 3 | C3 | 3 | 4 | F3 | 1 | 2 | E3 | 2 | 4 | D3 | 3 | 5 |
| Bit Test Memory with A (Logical Compare) | BIT | A5 | 2 | 2 | B5 | 2 | 3 | C5 | 3 | 4 | F5 | 1 | 2 | E5 | 2 | 4 | D5 | 3 | 5 |
| Jump Unconditional | JMP | - | - | - | BC | 2 | 2 | CC | 3 | 3 | FC | 1 | 2 | EC | 2 | 3 | DC | 3 | 4 |
| Jump to Subroutine | JSR | - | - | - | BD | 2 | 4 | CD | 3 | 5 | FD | 1 | 3 | ED | 2 | 4 | DD | 3 | 5 |

Symbols: $O p=$ Operation
\# = Instruction

Table 2-3 Read/Modify/Write Instructions

|  |  | Addressing Mode |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Implied (A) |  |  | Implied (X) |  |  | Direct |  |  | Indexed (No Offset) |  |  | Indexed (8-Bit Offset) |  |  |
| Operation | Mnemonic | $\begin{gathered} \text { Op } \\ \text { Code } \end{gathered}$ | $\begin{gathered} \# \\ \text { Bytes } \end{gathered}$ | \# Cycles | $\begin{aligned} & \text { Op } \\ & \text { Code } \end{aligned}$ | $\begin{gathered} \# \\ \text { Bytes } \end{gathered}$ | \# Cycles | $\begin{gathered} \text { Op } \\ \text { Code } \end{gathered}$ | $\begin{gathered} \# \\ \text { Bytes } \end{gathered}$ | \# Cycles | Op Code | $\begin{gathered} \# \\ \text { Bytes } \end{gathered}$ | $\begin{gathered} \# \\ \text { Cycles } \end{gathered}$ | $\begin{gathered} \mathrm{Op} \\ \text { Code } \end{gathered}$ | $\begin{gathered} \# \\ \text { Bytes } \end{gathered}$ | \# Cycles |
| Increment | INC | 4C | 1 | 1 | 5C | 1 | 1 | 3C | 2 | 4 | 7 C | 1 | 3 | 6C | 2 | 5 |
| Decrement | DEC | 4A | 1 | 1 | 5A | 1 | 1 | 3A | 2 | 4 | 7A | 1 | 3 | 6A | 2 | 5 |
| Clear | CLR | 4F | 1 | 1 | 5F | 1 | 1 | 3F | 2 | 4 | 7 F | 1 | 3 | 6 F | 2 | 5 |
| Complement | COM | 43 | 1 | 1 | 53 | 1 | 1 | 33 | 2 | 4 | 73 | 1 | 3 | 63 | 2 | 5 |
| Negate <br> (2's Complement) | NEG | 40 | 1 | 1 | 50 | 1 | 1 | 30 | 2 | 4 | 70 | 1 | 3 | 60 | 2 | 5 |
| Rotate Left Thru Carry | ROL | 49 | 1 | 1 | 59 | 1 | 1 | 39 | 2 | 4 | 79 | 1 | 3 | 69 | 2 | 5 |
| Rotate Right Thru Carry | ROR | 46 | 1 | 1 | 56 | 1 | 1 | 36 | 2 | 4 | 76 | 1 | 3 | 66 | 2 | 5 |
| Logical Shift Left | LSL | 48 | 1 | 1 | 58 | 1 | 1 | 38 | 2 | 4 | 78 | 1 | 3 | 68 | 2 | 5 |
| Logical Shift Right | LSR | 44 | 1 | 1 | 54 | 1 | 1 | 34 | 2 | 4 | 74 | 1 | 3 | 64 | 2 | 5 |
| Arithmetic Shift Right | ASR | 47 | 1 | 1 | 57 | 1 | 1 | 37 | 2 | 4 | 77 | 1 | 3 | 67 | 2 | 5 |
| Arithmetic Shift Left | ASL | 48 | 1 | 1 | 58 | 1 | 1 | 38 | 2 | 4 | 78 | 1 | 3 | 68 | 2 | 5 |
| Test for Negative or Zero | TST | 4D | 1 | 1 | 50 | 1 | 1 | 30 | 2 | 4 | 70 | 1 | 3 | 6D | 2 | 5 |

Symbols: $\mathrm{Op}=$ Oparation $\quad \#=$ Instruction

Table 2-4 Branch Instructions

|  |  | Relative Addressing Mode |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Operation | Mnemonic | Op Code | $\begin{gathered} \# \\ \text { Bytes } \end{gathered}$ | \# Cycles |
| Branch Always | BRA | 20 | 2 | 3 |
| Branch Never | BRN | 21 | 2 | 2 or 3* |
| Branch IF Higher | BHI | 22 | 2 | 2 or 3* |
| Branch IF Lower or Same | BLS | 23 | 2 | 2 or 3* |
| Branch IF Carry Clear | BCC | 24 | 2 | 2 or 3* |
| (Branch IF Higher or Same) | (BHS) | 24 | 2 | 2 or 3* |
| Branch IF Carry Set | BCS | 25 | 2 | 2 or 3* |
| (Branch IF Lower) | (BLO) | 25 | 2 | 2 or 3* |
| Branch IF Not Equal | BNE | 26 | 2 | 2 or 3* |
| Branch IF Equal | BEQ | 27 | 2 | 2 or 3* |
| Branch IF Half Carry Clear | BHCC | 28 | 2 | 2 or 3* |
| Branch IF Half Carry Set | BHCS | 29 | 2 | 2 or 3* |
| Branch IF Plus | BPL | 2A | 2 | 2 or 3* |
| Branch IF Minus | BMI | 2B | 2 | 2 or 3* |
| Branch IF Interrupt Mask Bit is Clear | BMC | 2C | 2 | 2 or 3* |
| Branch IF Interrupt Mask Bit is Set | BMS | 2D | 2 | 2 or 3* |
| Branch IF Interrupt Line is Low | BIL | 2E | 2 | 2 or 3* |
| Branch IF Interrupt Line is High | BIH | 2F | 2 | 2 or 3* |
| Branch to Subroutine | BSR | AD | 2 | 4 |

$$
\text { Symbol: } \mathrm{Op}=\text { Operation } \quad \#=\text { Instruction }
$$

* If branched, each instruction will be a 3-cycle instruction.

Table 2-5 Bit Processing Instructions

|  |  | Addressing Mode |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Bit Set/Clear |  |  | Bit Test and Branch |  |  |
| Operations | Mnemonic | $\begin{aligned} & \text { Op } \\ & \text { Code } \\ & \hline \end{aligned}$ | $\begin{gathered} \# \\ \text { Bytes } \end{gathered}$ | $\begin{gathered} \# \\ \text { Cycles } \end{gathered}$ | $\begin{aligned} & \text { Op } \\ & \text { Code } \end{aligned}$ | $\begin{gathered} \# \\ \text { Bytes } \end{gathered}$ | $\begin{gathered} \# \\ \text { Cycles } \end{gathered}$ |
| Branch IF Bit n is Set | BRSET n ( $\mathrm{n}=0 . . . . .7$ ) | - | - | - | 2•n | 3 | 4 or 5 * |
| Branch IF Bit n is Clear | BRCLR n ( $\mathrm{n}=0 . . . .7$ ) | - | - | - | $01+2 \cdot n$ | 3 | 4 or 5 * |
| Set Bit n | BSET $n(n=0 \ldots . .7)$ | 10+2•n | 2 | 4 | - | - | - |
| Clear Bit n | BCLR $n(\mathrm{n}=0 . . . .7)$ | $11+2 \cdot n$ | 2 | 4 | - | - | - |

Symbol: Op = Operation
\# = Instruction

* If Branched, each instruction will be a 5 -cycle instruction.

Table 2-6 Control Instructions

|  |  | Implied |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Operation | Mnemonic | Op <br> Code | $\#$ <br> Bytes | $\#$ <br> Cycles |  |
| Transfer A to X | TAX | 97 | 1 | 1 |  |
| Transfer X to A | TXA | $9 F$ | 1 | 1 |  |
| Set Carry Bit | SEC | 99 | 1 | 1 |  |
| Clear Carry Bit | CLC | 98 | 1 | 1 |  |
| Set Interrupt Mask Bit | SEI | $9 B$ | 1 | 1 |  |
| Clear Interrupt Mask Bit | CLI | $9 A$ | 1 | 1 |  |
| Software Interrupt | SWI | 83 | 1 | 9 |  |
| Return from Subroutine | RTS | 81 | 1 | 4 |  |
| Return from Interrupt | RTI | 80 | 1 | 7 |  |
| Reset Stack Pointer | RSP | $9 C$ | 1 | 1 |  |
| No-Operation | NOP | $9 D$ | 1 | 1 |  |

Symbol: $O p=$ Operation \# = Instruction

Table 2-7 Instruction Set

|  | Addressing Modes |  |  |  |  |  |  |  |  |  | Condition Code |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Mnemonic | Implied | Immediate | Direct | Extended | Relative | Indexed (No Offset) | Indexed (8 Bits) | Indexed (16 Bits) | Bit Set/ Clear | Bit <br> Test \& Branch | H | 1 | N | Z | C |
| ADC |  | $x$ | $x$ | x |  | $x$ | x | X |  |  | $\wedge$ | $\bullet$ | $\wedge$ | $\wedge$ | $\wedge$ |
| ADD |  | X | $x$ | X |  | X | $\times$ | x |  |  | $\wedge$ | $\bullet$ | $\wedge$ | $\wedge$ | $\wedge$ |
| AND |  | $\times$ | $x$ | X |  | x | $x$ | x |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\bullet$ |
| ASL | x |  | x |  |  | x | $x$ |  |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\wedge$ |
| ASR | x |  | x |  |  | $\times$ | X |  |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\wedge$ |
| BCC |  |  |  |  | X | , |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BCLR |  |  |  |  |  |  |  |  | x |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BCS |  |  |  |  | $x$ |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BEQ |  |  |  |  | $x$ |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BHCC |  |  |  |  | X |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BHCS |  |  |  |  | X |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BHI |  |  |  |  | $\times$ |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BHS |  |  |  |  | $x$ |  |  |  |  |  | - | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BIH |  |  |  |  | X |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BIL |  |  |  |  | $\times$ |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BIT |  | x | x | $\times$ |  | x | x | x |  |  | $\bullet$ | - | $\wedge$ | $\wedge$ | $\bullet$ |
| BLO |  |  |  |  | X |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BLS |  |  |  |  | $x$ |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BMC |  |  |  |  | x |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BMI |  |  |  |  | $x$ |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BMS |  |  |  |  | X |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BNE |  |  |  |  | x |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | - |
| BPL |  |  |  |  | X |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BRA |  |  |  |  | x |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| Symbols for condition code: <br> H Half Carry (From Bit 3) <br> I Interrupt Mask <br> $\mathrm{N} \quad$ Negative (Sign Bit) <br> Z Zero |  |  |  |  | $\stackrel{C}{C}$ | Carry/Borrow <br> Test and Set if True, Cleared Otherwise Not Affected |  |  |  |  |  |  | (Continued) |  |  |

Table 2-7 Instruction Set (Continued)

| Mnemonic | .Addressing Modes |  |  |  |  |  |  |  |  |  | Condition Code |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Implied | Immediate | Direct | Extended | Relative | Indexed (No Offset) | Indexed (8 Bits) | Indexed (16 Bits) | Bit Set/ Clear | Bit <br> Test \& Branch | H | 1 | N | Z | C |
| BRN |  |  |  |  | X |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BRCLR |  |  |  |  |  |  |  |  |  | X | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\wedge$ |
| BRSET |  |  |  |  |  |  |  |  |  | $\times$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\wedge$ |
| BSET |  |  |  |  |  |  |  |  | x |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| BSR |  |  |  |  | X |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| CLC | $x$ |  |  |  |  |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | 0 |
| CLI | $x$ |  |  |  |  |  |  |  |  |  | $\bullet$ | 0 | $\bullet$ | $\bullet$ | $\bullet$ |
| CLR | x |  | X |  |  | $x$ | $x$ |  |  |  | $\bullet$ | $\bullet$ | 0 | 1 | $\bullet$ |
| CMP |  | $\times$ | $x$ | x |  | x | x | x |  |  | $\bullet$ | - | $\wedge$ | $\wedge$ | $\wedge$ |
| COM | X |  | $x$ |  |  | x | $x$ |  |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | 1 |
| CPX |  | X | $x$ | X |  | $x$ | x | x |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\wedge$ |
| DEC | x |  | $x$ |  |  | x | x |  |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\bullet$ |
| EOR |  | x | $x$ | X |  | $x$ | x | x |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\bullet$ |
| INC | x |  | X |  |  | X | X |  |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\bullet$ |
| JMP |  |  | x | x |  | $x$ | $x$ | x |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| JSR |  |  | $x$ | x |  | $x$ | X | $x$ |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| LDA |  | $x$ | x | X |  | x | x | X |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\bullet$ |
| LDX |  | $\times$ | x | x |  | x | x | x |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\bullet$ |
| LSL | $x$ |  | $x$ |  |  | $x$ | X |  |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\wedge$ |
| LSR | X |  | $x$ |  |  | x | x |  |  |  | - | - | 0 | $\wedge$ | $\wedge$ |
| NEG | $x$ |  | $\times$ |  |  | $\times$ | x |  |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\wedge$ |
| NOP | x |  |  |  |  |  |  |  |  |  | $\bullet$ | - | $\bullet$ | $\bullet$ | $\bullet$ |
| ORA |  | X | X | x |  | X | x | x |  |  | $\bullet$ | - | $\wedge$ | $\wedge$ | $\bullet$ |
| ROL | $x$ |  | $x$ |  |  | $x$ | x |  |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\wedge$ |
| ROR | x |  | x |  |  | $\times$ | x |  |  |  | - | $\bullet$ | $\wedge$ | $\wedge$ | $\wedge$ |
| RSP | X |  |  |  |  |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| RTI | $x$ |  |  |  |  |  |  |  |  |  | $?$ | ? | ? | ? | ? |
| RTS | x |  |  |  |  |  |  |  |  |  | - | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| SBC |  | X | X | x |  | x | x | X |  |  | - | $\bullet$ | $\wedge$ | $\wedge$ | $\wedge$ |
| SEC | $x$ |  |  |  |  |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | 1 |
| SEI | x |  |  |  |  |  |  |  |  |  | $\bullet$ | 1 | $\bullet$ | $\bullet$ | $\bullet$ |
| STA |  |  | X | X |  | X | X | x |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\bullet$ |
| STX |  |  | X | $x$ |  | X | $x$ | x |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\bullet$ |
| SUB |  | x | x | x |  | x | X | x |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\wedge$ |
| SWI | $x$ |  |  |  |  |  |  |  |  |  | $\bullet$ | 1 | $\bullet$ | $\bullet$ | $\bullet$ |
| TAX | x |  |  |  |  |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| TST | $x$ |  | X |  |  | x | x |  |  |  | $\bullet$ | $\bullet$ | $\wedge$ | $\wedge$ | $\bullet$ |
| TXA | X |  |  |  |  |  |  |  |  |  | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ | $\bullet$ |
| Symbols for condition code: <br> H Half Carry (From Bit 3) <br> I Interrupt Mask <br> $N \quad$ Negative (Sign Bit) <br> Z Zero |  |  |  |  | $\begin{aligned} & \text { C } \\ & \stackrel{+}{?} \end{aligned}$ | Carry/Borrow <br> Test and Set if True, Cleared Otherwise <br> Not Affected <br> Load CC Register From Stack |  |  |  |  |  |  |  |  |  |

Table 2-8 OP Code Map

|  | Bit Manipulation |  | Branch <br> Rel | Read/Modify/Write |  |  |  |  | Control |  | Register/Memory |  |  |  |  |  | + HIGH |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Test \& Branch | Set/ Clear |  | DIR | A | X | , X1 | . $\times 0$ | IMP | IMP | IMM | DIR | EXT | , X 2 | , X 1 | . XO |  |
|  | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F |  |
| 0 | BRSETO | BSETO | BRA | NEG |  |  |  |  | RTI* | - | SUB |  |  |  |  |  | 0 |
| 1 | BRCLRO | BCLRO | BRN | - |  |  |  |  | RTS* | - | CMP |  |  |  |  |  | 1 |
| 2 | BRSET1 | BSET1 | BHI | - |  |  |  |  | - | - | SBC |  |  |  |  |  | 2 |
| 3 | BRCLR1 | BCLR1 | BLS | COM |  |  |  |  | SWI* | - | CPX |  |  |  |  |  | 3 L |
| 4 | BRSET2 | BSET2 | BCC | LSR |  |  |  |  | - | - | AND |  |  |  |  |  | 40 |
| 5 | BRCLR2 | BCLR2 | BCS | - |  |  |  |  | - | - | BIT |  |  |  |  |  | 5 W |
| 6 | BRSET3 | BSET3 | BNE | ROR |  |  |  |  | - | - | LDA |  |  |  |  |  | 6 |
| 7 | BRCLR3 | BCLR3 | BEQ | ASR |  |  |  |  | - | TAX | STA (+1) |  |  |  |  |  | 7 |
| 8 | BRSET4 | BSET4 | BHCC | LSL/ASL |  |  |  |  | - | CLC | EOR |  |  |  |  |  | 8 |
| 9 | BRCLR4 | BCLR4 | BHCS | ROL |  |  |  |  | - | SEC | ADC |  |  |  |  |  | 9 |
| A | BRSET5 | BSET5 | BPL | DEC |  |  |  |  | - | CLI | ORA |  |  |  |  |  | A |
| B | BRCLR5 | BCLR5 | BMI | - |  |  |  |  | - | SEI | ADD |  |  |  |  |  | B |
| C | BRSET6 | BSET6 | BMC | INC |  |  |  |  | - | RSP | JMP(-1) |  |  |  |  |  | C |
| D | BRCLR6 | BCLR6 | BMS | TST |  |  |  |  | - | NOP | BSR* | JSR(+1) |  | JSR |  | JSR(+1) | D |
| E | BRSET 7 | BSET7 | BIL | - |  |  |  |  | - | - | LDX |  |  |  |  |  | E |
| F | BRCLR7 | BCLR7 | BIH | CLR |  |  |  |  | - | TXA | - | STX ${ }^{\text {( }} 1$ ) |  |  |  |  | F |
|  | $3 / 4$ or 5 | 2/4 | $2 / 2$ or 3 | 2/4 | 1/1 | 1/1 | 2/5 | 1/3 | 1/* | 1/1 | 2/2 | 2/3 | 3/4 | $3 / 5$ | 2/4 | 1/2 |  |

(NOTES) 1. " - " is an undefined operation code.
2. The figure in the lowest row of each column gives the number of bytes and the cycles needed for the instruction. The number of cycles for the asterisked (*) mnemonics is a follows:

| RTI | 7 |
| :--- | :--- |
| RTS | 4 |
| SWI | 9 |
| BSR | 4 |

3. The parenthesized figure must be added to the cycle count of the associated instruction.
4. If the instruction is branched, the cycle count is the larger figure.
5. Executable Instruction

Shown below are the meanings of symbols and abbreviations.
(1) Operation
( ) : contents
*: movement direction
+: addition
-: subtraction
$\wedge$ : AND
V: OR
$\oplus$ : Exclusive OR
$\bar{x}$ : NOT
(2) Register symbols in MPU

ACCA: accumulator A
CC: condition codes register
IX: index register, 8 bits
PC: program counter, 12 bits
PCH: upper three bits of program counter
PCL: lower eight bits of program counter
SP: stack pointer, 5 bits
(3) Memory and addressing codes

M: stored address
MH: upper eight bits of stored address
ML: lower eight bits of stored address
M+l: stored address M plus l
Msp: stored address indicated by stack pointer
Imm: immediate value
Disp: displacement value $=\mathrm{M}$ - (IX)
D: displacement value $=$ M - (IX)
DH: displacement value $=$ upper eight bits
DL: displacement value $=$ lower eight bits
Rel: relative value
IMPLIED: implied addressing
RELATIVE: relative addressing
ACCUMULATOR: accumulator addressing
INDEX REG.: index register addressing
IMMEDIATE: immediate addressing
DIRECT: direct addressing
EXTENDED: extended addressing
INDEXED 0 BYTE OFFSET: indexed addressing 0 byte offset
INDEXED 1 BYTE OFFSET: indexed addressing l byte offset

INDEXED 2 BYTE OFFSET: indexed addressing 2 byte offset
EA: effective address
(4) Contents of bits 0 through 4 of condition codes register

C: carry - borrow bit 0
z: zero bit 1
N: negative bit 2
I: interrupt mask bit 3
H: half carry from bit 3 to bit 4 bit 4
(5) Status of each bit before execution of instruction

An: bit $n$ of ACCA $(n=7,6,5, \ldots, 0)$
Mn : bit n of $\mathrm{M}(\mathrm{n}=7,6,5, \ldots, 0)$
Xn: bit n of $\mathrm{IX}(\mathrm{n}=7,6,5, \ldots . .0)$
(6) Status of each bit on result after execution of instruction Rn: bit $n$ of result ( $n=7,6,5, \ldots ., 0$ )
(7) Symbols on instruction's format

P: each addressing mode on Immediate, Direct, Extended and index of 0,1 and 2 byte offset

Q: each addressing mode on Direct and index of 0 and 1 byte offset

A: accumulator addressing mode
X: index register addressing mode
DR: direct addressing mode
dd: relative operand (8 bits)
n : bit n of memory $(\mathrm{n}=7,6,5, \ldots, 0)$
(8) Status of HD63L05'S interrupt pin

INT: status of interrupt pin (high, low)



| Lodical Operation |
| :---: |
| AND |


| AND (logical AND) |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Format |  |  | Condition Codes |  |  |
| AND P |  |  | H: Not affected. <br> I: Not affected. <br> N : Set if the most significant bit of the result is 1 ; otherwise cleared. <br> Z: Set if the result is 0; otherwise cleared. <br> C: Not affected. |  |  |
| ACCA <- ( ${ }^{\text {a }}$ (CCA) $\Lambda(\mathrm{M})$ |  |  |  |  |  |
| Description |  |  |  |  |  |
| Performs logical AND between the contents of ACCA and the contents of $M$, and places the result in ACCA. |  |  |  |  |  |
| Addressing Mode and Number of MPU Cycles |  |  |  |  |  |
| Addressing Mode | Oper and <br> Mnemonic,type |  | Byte 1 Byte 2 Byte 3 | NO. of bytes | Number of MPU cycles |
| IMMEDIATE | AND | ; Imm | A4 : Imm : | 2 | 2 |
| DIRECT | AND | 1 M | B4 : M ; | 2 | 3 |
| EXIENDED | AND | 1 M | $\mathrm{C4}: 1 \mathrm{MH}: \mathbf{M L}$ | 3 | 4 |
| $\begin{aligned} & \text { INDEXED } 0 \text { BYTE } \\ & \text { OFFSET } \end{aligned}$ | AND | 1, X | F4 1 | 1 | 2 |
| INDEXED 1 BYTE <br> OFFSEET   <br> INDEXED 2 BYTE <br> OFFSET   | AND | 'Disp; x | E4 ; D : | 2 | 4 |
|  | AND | Disp, X | $\mathrm{D} 4 \mathrm{DH}^{\text {a }}$ : DL | 3 | 5 |
|  |  | : |  |  |  |
|  |  | ' | ! |  |  |
| Example |  | ERASE UPPER 4 BITS (RESTORE) |  |  |  |
| $\begin{array}{ll} \text { LDA } & 0, X \\ \text { AND } & \text { \#\$0F } \\ \text { STA } & 0, X \\ \text { INC } & X \\ \text { BRA } & \text { LOOP } \end{array}$ |  |  |  |  |  |



| ASR (Arithmetic Shift Right) |  |  |  |
| :---: | :---: | :---: | :---: |
| Format |  | Condition Codes |  |
| ASR $Q$ ASR A ASR X |  | H: Not affected. <br> I: Not affected. <br> N : Set if the most significant bit of the result is 1 ; otherwise cleared. <br> Z: Set if the result is 0 ; otherwise cleared. <br> C: Set if, before a shift, the least significant bit is l; otherwise cleared. |  |
| Operation |  |  |  |
| Description |  |  |  |
| Shifts the contents of ACCA, IX or M one place to the right. The bit 7 is held constant. The bit 0 is loaded into the carry bit $C$. |  |  |  |
| Addressing Mode and Number of MPU Cycles |  |  |  |
| Addressing <br> Mode | ;Oper and <br> Mnemonic type | Instruction code Byte l:Byte 21 Byte 3 | $\begin{array}{l\|l\|} \hline & \text { Number } \\ \hline \text { No. of } & \text { of MPU } \\ \text { bytes } & \text { cycles } \\ \hline \end{array}$ |
| ACCUMULATOR | ASR : A | 47 ; | 1 1 1 |
| INDEX REG. | ASR : X | 57 | $1 \quad 1$ |
| DIRECT | ASR : M | $37: 1$ | $2 \quad 4$ |
| INDEXED 0 BYTE <br> OFSET   <br> OFDEXED I  <br> INYTE   <br> OFFSET   | ASR : X | $77:$ | 1 3 |
|  | ASR 'Disp, X | $67:$ D : | $2 \quad 5$ |
|  |  | ' 1 |  |
|  | , | $1:$ |  |
|  |  | $\vdots$ |  |
| Example ${ }^{\text {E }}$ | ASR WORK BRANCH OP <br> BCS OPTO  <br> ASR WORK  <br> BCS OPT1  <br> ASR WORK  <br> BCS OPT2  | TION (KEEPING BIT7) |  |


| Conditional Branch |
| :---: |
| BCC |



| Bit Control |
| :---: |
| BCLR |


| BCLR (Bit CLear bit n) |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Format |  |  | Condition codes |  |
| BCLR n, DR |  |  | Not affected. |  |
| Operation |  |  |  |  |
| Mn <- 0 |  |  |  |  |
| Description |  |  |  |  |
| Clears the bit n ( $\mathrm{n}=0$ through 7) of M. The other bits are unaffected. |  |  |  |  |
| Addressing Mode and Number of MPU Cycles |  |  |  |  |
| Addressing Mode | MnemonicOperand <br> type |  | Instruction code Number <br> 1:Byte 2 Byte 3 No. of of mpu <br> bytes cycles  |  |
| DIRECT | BCLR | 0, M | $11: \mathrm{M}$ | $2 \quad 4$ |
| DIRECT | BCLR | 1,M | 13 M | $2 \quad 4$ |
| DIRECT | BCLR | 2, M | $15: M$ | 4 |
| DIRECT | BCLR | 3, M | 17 : M | $2 \quad 4$ |
| DIRECT | BCLR | 4,M | 19 M | $2 \quad 4$ |
| DIRECT | BCLR | 5,M | $1 \mathrm{~B}, \mathrm{M}$ | 2 - 4 |
| DIRECT | BCLR | 6,M | ID $\quad \mathrm{M}$ | $2 \quad 4$ |
| DIRECT | BCLR | 7, M | $\mathrm{IF}: \mathrm{M}$ | 2 4 |
| Example | LDA CNTRL $* *$ MAKE CONTROL CODE <br> AN   <br> AND \#\$FO $\star$ <br> ORA WORK $\star$ <br> STA CNTRL $\star$ <br> BCLR 0,CNRL CLEAR BIT $0,6,7$ <br> BCLRSOLUTELY   <br> BCLR 6,CNTRL  <br> 7,CNTRL   |  |  |  |


| BCS (Branch if Carry Set) |  |  |
| :--- | :--- | :--- |
| Format |  | Condition Codes |
| BCS dd |  |  |
| Operation affected. |  |  |
| PC <- (PC) $+0002+$ Rel if (C) $=1$ |  |  |

Tests the state of the $C$ bit and causes a branch if $C$ is 1.
If branched,this instruction will be a 3-cycle instruction.


| Conditional Branch |
| :---: |
| BEQ |

BEQ (Branch of EQual)

| Format | Condition Codes |
| :--- | :---: |
| BEQ dd | Not affected. |
| Operation |  |
| PC <- (PC) +0002+Rel if (Z) $=1$ |  |

Description

Tests the state of the Z bit and causes a branch if Z is 1.

If branched,this instruction will be a 3-cycle instruction.


| Conditional Branch |
| :---: |
| BHOC |







| Conditional Branch |
| :---: |
| BIL |




| Conditional Branch |
| :---: |
| BLO |




| Conditional Branch |
| :---: |
| BMC |



| BMI (Branch if MInus) |  |
| :---: | :---: |
| Format |  |
| BMI dd | Condition Codes |
| Operation |  |
| PC $<-$ (PC) $+0002+$ Rel if $(\mathrm{N})=1$ |  |

Tests the state of the N bit, and causes a branch if N is 1 .
If branched,this instruction will be a 3-cycle instruction.


| Conditional Branch |
| :---: |
| BMS |



| Conditional Branch |
| :---: |
| BNE |


| BNE (Branch if Not Equal) |  |  |  |
| :---: | :---: | :---: | :---: |
| Format |  | Condition Codes |  |
| BNE dd |  | Not affected. |  |
| Operation |  |  |  |
| PC <- (PC) +0002+Rel if ( Z ) $=0$ |  |  |  |
| Description |  |  |  |
| Tests the state of the Z bit and causes a branch if z is 0 . <br> Following a compare or subtract instruction, BNE will cause a branch if the arguments were different. <br> If branched,this instruction will be a 3-cycle instruction. |  |  |  |
| Addressing Mode and Number of MPU Cycles |  |  |  |
| Addressing Mode | Mremonic: Operand | Instruction code Byte 1 Byte 2 Byte 3 |  |
| RELATIVE | BNE : Rel | 26 Rel: | 22 or 3 |
|  |  | - |  |
|  | , | $i$ |  |
|  |  | $!$ |  |
|  |  | $!$ |  |
|  | , | ' |  |
|  |  |  |  |
|  |  |  |  |
| Example |  |  |  |
| LDA WORK   <br> BNE CCCC WORK NOT $=0$  <br> CMP RESULT   <br> BNE DDDD WORK NOT $=$ RESULT  |  |  |  |


| Conditional Branch |
| :---: |
| BPL |




| Conditional Branch |
| :---: |
| BRCIR |



| Unconditional Branch |
| :---: |
| BRN |





| Subroutine Control |
| :---: |
| BSR |



| Bit Control |
| :---: |
| CIC |



| CLI (CLear Interrupt mask) |  |
| :---: | :---: |
| Format | Condition Codes |
| CLI | H: Not affected. <br> I: Cleared. <br> N: Not affected. |
| Operation | C: Not affected. |
| I <- 0 |  |
| Description |  |

Clears the interrupt mask bit in the processor condition code register, This enables the microprocessor to service interrupts. Interrupts that were pending while the I bit was set will now begin to have effect.



| Comparison .and Test |
| :---: |
| CMP |




| Comparison and Test |
| :---: |
| CPX |




| Logical Operation |
| :---: |
| EOR |



| Arithmetic Operation |
| :---: |
| INC |



| Conditional Branch |
| :---: |
| JMP |



| Subroutine Control |
| :---: |
| JSR |



| Load \& Store |
| :---: |
| LDA |






| Arithmetic Operation |
| :---: |
| NEG |



| NOP (No OPeration) |  |  |  |
| :---: | :---: | :---: | :---: |
| Format |  | Condition Codes |  |
| NOP |  | Not affected. |  |
| Operation |  |  |  |
| Description |  |  |  |
| This is a single-byte instruction which causes only the program counter to be incremented. No other registers are changed. |  |  |  |
| Addressing Mode and Number of MPU Cycles |  |  |  |
| Addressing Mode | Mnemonic <br> 'Operand <br> ,type |  |  |
| IMPLIED | NOP | 9D | $1 \quad 1$ |
|  | 1 | 1 |  |
|  | 1 | i |  |
|  | , | ! |  |
|  | ' | , ! |  |
|  | , | ' |  |
|  | ! | ' 1 |  |
|  |  | ! |  |
| Example | NOP ** DELAY <br> NOP  <br> NOP  <br> NOP  <br> NOP  <br> NOP  |  |  |


| Logical Operation |
| :---: |
| ORA |




| Shift \& Rotation |
| :---: |
| ROR |






| Arithmetic Opeartion |
| :---: |
| SBC |



| Bit Control |
| :---: |
| SEC |



| Bit Control |
| :---: |
| SEI |



| Load \& Store |
| :---: |
| STA |


| STA (STbre Accumulator) |  |  |  |
| :---: | :---: | :---: | :---: |
| Format |  | Condition Codes |  |
| STA P |  | H: Not affected. <br> I: Not affected. <br> N : Set if the most significant bit of ACCA is 1 ; otherwise cleared. <br> Z: Set if the contents of ACCA are 0; otherwise cleared. <br> C: Not affected. |  |
| $\frac{\text { Operation }}{M<-\quad \text { (ACCA) }}$ |  |  |  |
| Description |  |  |  |
| Stores the contents of ACCA in memory. The contents of ACCA remain the same. |  |  |  |
| Addressing Mode and Number of MPU Cycles |  |  |  |
| Addressing Mode | MnemonicOperand <br> type |  |  |
| DIRECT | STA : M | B7 : M : | 2 4 |
| EXTENDED | STA : M | C7 : MH ; ML | 3 5 |
| ${ }^{\text {INPEEXED }} 0$ | STA : X | F7 i | $1 \quad 3$ |
| INDEXED 1 BYTE OFFSET | STA Disp, X | E7 : D | 2 5 |
| OFFSSETD 2 BYTE | STA Disp, X | D7 ; DH : DL | 3 l |
|  |  | ' 1 |  |
|  |  | ! ' |  |
|  |  | ! |  |
| Example | LDA VALI <br> STA WORK <br> LDA RESULT <br> STA $0, X$ <br> LDA \#\$FF <br> STA EXVAL5,X |  |  |




| Interrupt Control |
| :---: |
| SWI |



| Transfer |
| :---: |
| TAX |



| $\cdot$ Comparison \& Test |
| :---: |
| TST |



| Transfer |
| :---: |
| TXA |




Figure 4-1 Pin Assignment (Top View)


Note
Lead of corner part is below the bottom of package
Figure 4-2 Dimensional Outline (Unit : mm)
5. Electrical Characteristics

ABSOLUTE MAXIMUM RATINGS

| Item | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Supply Voltage | $\mathrm{V}_{\mathrm{CC}}$ | $-0.3 \sim+5.5$ | V |
| Input Voltage | $\mathrm{V}_{\text {in }}$ | $-0.3 \sim \mathrm{~V}_{\mathrm{CC}}+0.3$ | V |
| Output Voltage | $\mathrm{V}_{\text {out }}$ | $-0.3 \sim \mathrm{~V}_{\mathrm{CC}}+0.3$ | V |
| Operating Temparature | $\mathrm{T}_{\text {opr }}$ | $-20 \sim+75$ | ${ }^{\circ} \mathrm{C}$ |
| Storage Temparature | $\mathrm{T}_{\text {stg }}$ | $-55 \sim+125$ | ${ }^{\circ} \mathrm{C}$ |

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded,it could affect reliability of LSI.

ELECTRICAL CHARACTERISTICS ( $\mathrm{V}_{\mathrm{CC}}=3.00 .8 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{Ta}=-20 \sim+75^{\circ} \mathrm{C}$, typ means typical value at $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ unless otherwise noted.)

- DC CHARACTERISTICS

| Item |  |  | Symbol | Test Condition | min | typ | max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { Input "High" } \\ & \text { Level Voltage } \end{aligned}$ | XTAL, XIN |  | $\mathrm{V}_{\text {IH }}$ | $\begin{aligned} & \text { Connect } \mathrm{C}_{\mathrm{L}}=0.5 \mathrm{~F} \\ & \text { to } \mathrm{V}_{\mathrm{CH}} \end{aligned}$ | $\mathrm{V}_{\mathrm{CC}}-0.3$ | - | $\mathrm{V}_{\mathrm{CC}}$ | V |
|  | $\overline{\text { RES }}$, $\overline{\mathrm{INT}}, \mathrm{SB}$ |  |  |  | $0.5 \mathrm{~V}_{C C}+0.9$ | - | $\mathrm{V}_{\mathrm{CC}}$ | V |
|  | TIMER |  |  |  | 0.8 V CC | - | $\mathrm{V}_{\text {CC }}$ | V |
|  | NUM <br> (Normal | Mode) |  |  | $\mathrm{V}_{\mathrm{CC}}-0.2$ | - | $\mathrm{V}_{\mathrm{CC}}$ | V |
| ```Input "Low" Level Voltage``` | XTAL, XIN |  | $\mathrm{V}_{\text {IL }}$ | $\begin{aligned} & \text { Connect } \mathrm{C}_{\mathrm{L}}=0.5 \mathrm{~F} \\ & \text { to } \mathrm{V}_{\mathrm{CH}} \end{aligned}$ | $\mathrm{V}_{\text {S }}$ | - | $\mathrm{V}_{C C}{ }^{-1.8}$ | V |
|  | $\overline{\mathrm{RES}}, \overline{\mathrm{INT}}, \mathrm{SB}$ |  |  |  | $\mathrm{V}_{\text {SS }}$ | - | 0.2VCC | V |
|  | TIMER |  |  |  | $\mathrm{V}_{\text {SS }}$ | - | $0.2 \mathrm{~V}_{\mathrm{CC}}$ | V |
|  | NUM <br> (Test Mode) |  |  |  | $\mathrm{V}_{\text {SS }}$ | - | 0.2 | V |
| Self Check Input Voltage | NUM (Self Check Mode) |  | $\mathrm{V}_{\text {IM }}$ |  | $\begin{array}{r} 0.5 \mathrm{VCC} \\ -0.2 \\ \hline \end{array}$ | - | $\begin{array}{r} 0.5 \mathrm{VCC} \\ +0.2 \\ \hline \end{array}$ | V |
| Input Pul1- <br> Up Current | $\overline{\mathrm{RES}}$ (INT:Mask Option) |  | $-\mathrm{I}_{\mathrm{R} 1}$ | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}, \mathrm{Vin}=0 \mathrm{~V}$ | 3 | 15 | 30 | $\mu \mathrm{A}$ |
| Input Leackage Current | TIMER, SB |  | IIN | Vin $=0 \mathrm{~V} \mathrm{~V}_{\mathrm{CC}}$ | - | - | 1.0 | $\mu \mathrm{A}$ |
| Current <br> Dissipation | Crystal <br> Oscil- <br> lation | During System Operation | $\mathrm{I}_{\mathrm{CC} 1}$ | f $=400 \mathrm{kHz}$ <br> No load. <br> Tested after setting up the internal status by self check. | - | 100 | 200 | $\mu \mathrm{A}$ |
|  |  | At Halt |  |  | - | 40 | 60 | $\mu \mathrm{A}$ |
|  |  | $\begin{aligned} & \text { At } \\ & \text { Stand-By } \end{aligned}$ |  |  | - | 1 | 5 | $\mu \mathrm{A}$ |
|  |  | At A/D Operation |  |  | - | 160 | 400 | $\mu \mathrm{A}$ |
|  | RC <br> Oscillation | During System Operation | $\mathrm{I}_{\mathrm{CC} 2}$ | $\mathrm{R}=100 \mathrm{kHz}$ <br> No load. <br> Tested after setting up the internal status by self check. | - | 120 | 200 | $\mu \mathrm{A}$ |
|  |  | At Halt |  |  | - | 30* | 60\% | $\mu \mathrm{A}$ |
|  |  | At Stand-By |  |  | - | 1 | 5 | $\mu \mathrm{A}$ |
|  |  | At A/D Operation |  |  | - | 180 | 420 | $\mu \mathrm{A}$ |
| $\begin{aligned} & \text { Output "Low" } \\ & \text { Level Voltage } \end{aligned}$ | E |  | $\mathrm{V}_{\text {OL }}$ | $\mathrm{I}_{\mathrm{OL}}=30 \mathrm{~A}$ | - | - | 0.3 | V |

* In the case that OSC1 is stopped by Halt.

These values can be changed without notice, because they are provisional.

## - aC CHARACTERISTICS

| It em | Symbol | Test Condition | min | typ | max | unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operating Clock Frequency | $\mathrm{f}_{\mathrm{cf}}$ |  | 100 | 400 | 500 | kHz |
| Cycle Time | $\mathrm{f}_{\text {cyc }}$ |  | 8 | 10 | 40 | $\mu \mathrm{s}$ |
| Oscillation Frequency (Resistor Option) | $\mathrm{f}_{\text {OSCR }}$ | $\mathrm{R}=100 \mathrm{k} \Omega \quad \pm 1 \%$ | 300 | 400 | 500 | kHz |
| External Clock Duty | Duty |  | 45 | 50 | 55 | \% |
| Oscillation Start Time (Crystal Option) | ${ }^{t}$ OSCf | $\mathrm{C}_{\mathrm{C}}=10 \mathrm{pF} \pm 20 \%, \mathrm{RS}=1 \mathrm{k} \Omega$ max | - | - | 150 | ms |
| Oscillation Start Time (Resistor Option) | ${ }^{\text {t OSCR }}$ | $\begin{aligned} & \mathrm{R}=100 \mathrm{k} \Omega \pm 1 \%, \\ & \text { Connect } \mathrm{C}_{\mathrm{L}}=0.5 \mu \mathrm{~F} \text { to } \mathrm{V}_{\mathrm{CH}} \end{aligned}$ | - | - | 2 | ms |
| Oscillation Start Time ( 32 kHz ) | ${ }^{\text {tosCl }}$ | $\mathrm{CC}=10 \mathrm{pF} \pm 20 \% . \mathrm{RS}=20 \mathrm{k} \Omega \max$ | - | - | 1 | s |
| Internal Capacitance ${ }^{\text {EXTAL }}$ | $\mathrm{C}_{0}$ |  | - | 10 | - | pF |
| XOUT |  |  | - | 10 | - | pF |
| Delay Time of Oscillation Delay Time | ${ }^{\text {P PLY }}$ | Selected by mask option | 0 | - | 500 | ms |
| Reset Delay Time | ${ }^{\text {t }}$ PLH | External Capacitance $=2.2 \mu \mathrm{~F}$ | 200 | - | - | ms |
| RES Pulse Width | tRWL |  | $\mathrm{t}_{\mathrm{cyc}}+1$ | - | - | $\mu \mathrm{s}$ |
| INT Pulse Width | ${ }^{\text {t }}$ PWL | When OSCl is not stopped by Halt | $t_{\text {cyc }}+1$ | - | - | $\mu \mathrm{s}$ |
|  |  | When OSCl is stopped by Halt. | 32 | - | - | $\mu \mathrm{s}$ |
| TIMER Pulse Width | ${ }^{\text {t }}$ TWL | In the case of counter | $t_{\text {cyc }}+1$ | - | - | $\mu \mathrm{s}$ |

- PORT CHARACTERISTICS

| Item |  | Symbol | Test Condition | min | typ | max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output "High" Level Voltage | Port A, B, C | $\mathrm{V}_{\mathrm{OH}}$ | CMOS Output, $\mathrm{I}_{0 \mathrm{H}}=-100 \mu \mathrm{~A}$ | $\mathrm{V}_{\mathrm{CC}}-0.3$ | - | - | V |
|  | Port A, B, C |  | Key Load CMOS Output $\mathrm{I}_{\mathrm{OH}}=-10 \mu \mathrm{~A}$ | $\mathrm{V}_{\mathrm{CC}}-0.3$ | - | - | V |
| Output "Low" Level Voltage | Port A, B, C | $\mathrm{V}_{\mathrm{OL}}$ | $I_{0 L}=100 \mu \mathrm{~A}$ | - | - | 0.3 | V |
| Input "High" Level Voltage | Port A, B, C | $\mathrm{V}_{\text {IH }}$ |  | $0.8 \mathrm{~V}_{\mathrm{CC}}$ | - | VCC | V |
| Input "Low" Level Voltage | Port A, B, C | $\mathrm{V}_{\text {IL }}$ |  | $\mathrm{V}_{\text {SS }}$ | - | $0.2 \mathrm{~V}_{\mathrm{CC}}$ | V |
| Input Leackage Current | Port A, B, C | $\left\|\mathrm{I}_{\text {IN }}\right\|$ | $\mathrm{V}_{\text {in }}=0 \mathrm{~V} \sim \mathrm{~V}_{\mathrm{CC}}$ | _ | - | 1.0 | $\mu \mathrm{A}$ |
| Input Pull-Up Current | Port A, B, C | $-\mathrm{I}_{\mathrm{R} 2}$ | $\mathrm{V}_{C C}=3.0 \mathrm{~V}, \mathrm{~V}_{\text {in }}=0 \mathrm{~V}$ | 4 | 20 | 40 | $\mu \mathrm{A}$ |

- LCD DRIVER OUTPUT CHARACTERISTICS $\left(V_{C C}=3.0 V, V_{S S}=0 \mathrm{~V}, \mathrm{Ta}=-20 \sim+75^{\circ} \mathrm{C}\right.$, unless otherwise noted.)

| Item |  | Symbol | Test Condition | min | typ | max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output "High" Level Voltage | Segment | ${ }^{+}$ | $\begin{aligned} \mathrm{V}= & 1.00 \mathrm{v}, \mathrm{v}=2.00 \mathrm{v} \\ & I_{0 H}=-1 \mu \mathrm{~A} \end{aligned}$ | 2.8 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{OH} 2}$ |  | 1.8 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{OH} 3}$ |  | 0.8 | - | - | V |
| Output "Low" Level Voltage | Segment | $\mathrm{v}_{\text {OL1 }}$ | $\begin{aligned} v= & 1.00 \mathrm{v}, \mathrm{v}=2.00 \mathrm{~S} \\ & I_{O L}=1 \mu \mathrm{~A} \end{aligned}$ | - | - | 2.2 | V |
|  |  | $\mathrm{v}_{\text {OL2 }}$ |  | - | - | 1.2 | v |
|  |  | $\mathrm{V}_{\text {OL3 }}$ |  | - | - | 0.2 | v |
| Output "High" Level Voltage | Common | $\mathrm{V}_{\mathrm{OH} 1}$ | $\begin{aligned} v= & 1.00 \mathrm{v}, \mathrm{v}=2.00 \mathrm{~V} \\ & I_{O H}=-5 \mu \mathrm{~A} \end{aligned}$ | 2.8 | - | - | v |
|  |  | $\mathrm{V}_{\mathrm{OH} 2}$ |  | 1.8 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{OH} 3}$ |  | 0.8 | - | - | V |
| Output "Low" Level Voltage | Common | $\mathrm{v}_{\text {OL } 1}$ | $\begin{aligned} \mathrm{V}= & 1.00 \mathrm{~V}, \mathrm{~V}=2.00 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{OH}}=5 \mu_{\mu} \mathrm{A} \end{aligned}$ | - | - | 2.2 | V |
|  |  | $\mathrm{v}_{\text {OL2 }}$ |  | - | - | 1.2 | V |
|  |  | $\mathrm{V}_{\text {OL3 }}$ |  | - | - | 0.2 | V |
| Dividing Resistor |  | $\mathrm{R}_{\mathrm{LCD}}$ | Tested between V and V | 45 | 90 | 180 | k |
| Output "High" Level Voltage | Segment | $\mathrm{V}_{\mathrm{OH}}$ | In the case of Output Port, $I_{0 H}=-30 \mu \mathrm{~A}$ | ${ }^{\mathrm{N} C C^{-0}}{ }^{-3}$ | - | - | V |
| Output "Low" Level Voltage | Segment | $\mathrm{V}_{\text {OL }}$ | In the case of Output Port, $I_{\text {OL }}=30 \mu \mathrm{~A}$ | - | - | 0.3 | V |



Figure 5-1 Output Leve1 of SEG and COM


Figure 5-2 Power Supply Circuit for LCD Display

- A/D CONVERTER CHARACTERISTICS * $V_{C C}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}, \mathrm{Ta}=-20^{\circ} \mathrm{C} \sim+75^{\circ} \mathrm{C}, \mathrm{C}=300 \mathrm{pF}$, unless otherwise noted.)

| Item |  | Symbol | Test Condition | min | typ | max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Conversion Accuracy | Resolution |  |  | - | - | 8 | bit |
|  | Absolute Accuracy |  | $\mathrm{V}_{\mathrm{RL}}=0.2 \mathrm{~V}<\mathrm{V}_{\text {in }}<\mathrm{V}_{\mathrm{RH}}=2.0 \mathrm{~V}$ | -2 | - | +2 | LSB |
| Reference Voltage | "High" Side | $\mathrm{V}_{\text {RH }}$ |  | - | - | VCC | V |
|  | "Low" Side | $\mathrm{V}_{\mathrm{RL}}$ |  | $\mathrm{v}_{\text {SS }}$ | - | - | V |
|  | $\mathrm{V}_{\mathrm{RH}}-\mathrm{V}_{\text {RL }}$ | $\mathrm{V}_{\text {REF }}$ |  | 2.0 | - | - | V |
|  | Input Range | VIN |  | $\mathrm{V}_{\mathrm{RL}}$ | - | $\mathrm{V}_{\mathrm{RH}}$ | V |
|  | Input Dynamic Range | $\mathrm{V}_{\text {DYN }}$ |  | 0.2 | - | $\mathrm{v}_{\text {CC }}{ }^{-1.0}$ | v |
| Ladder Resistor ( $\mathrm{VRH}^{-} \mathrm{V}_{\mathrm{RL}}$ ) |  | ${ }^{\mathrm{H}_{\mathrm{HL}}}$ |  | 40 | 80 | 160 | k $\Omega$ |
| Conversion Time |  | $\mathrm{t}_{\text {CNV }}$ |  | 2 | - | 4 | ms |
| Programmable <br> Voltage Comparison | Judge Error |  | $\mathrm{V}_{\mathrm{RL}}=0.2 \mathrm{~V}<\mathrm{V}_{\text {in }}<\mathrm{V}_{\mathrm{RH}}=2.0 \mathrm{~V}$ | -4 | - | +4 | LSB |
|  | Judge Time | ${ }^{\text {t CMP }}$ |  | - | - | 60 | $\mu \mathrm{s}$ |

* These value can be changed without notice, because they are provisional.

| $V_{\text {SS }} 0.2 \mathrm{~V} \quad \mathrm{~V}_{\mathrm{CC}}-1.0 \mathrm{~V} \quad \mathrm{~V}_{\mathrm{CC}}$ |
| :--- |
|    <br>   Dead <br> Zone   |

Analog Input Voltage
(When the input voltage is in the dead zone, the result of the conversion is not guaranteed.)

Figure 5-3 Dynamic Range of the Comparator


## 6. Application

### 6.1 Test Mode

(1) HD63L05 Test Mode

The HD63L05 can take two operation modes based on the state of the NUM terminal. When the NUM terminal is pulled up to Vcc,the MCU operates in the normal mode. However, when the NUM terminal is grounded to the GND, the HD63L05 goes into the test mode. This mode can be used for testing the MCU.
(2) Bus Line

When the HD63L05 is operating in the test mode,the connection with the external circuit is performed through I/O ports.

The port $A$ becomes the $o 2$ synchronous input data bus. In the test mode,the internal data bus which enters the CPU inside the MPU is disconnected, and all the data and instructions are sent to the CPU through the port $A$.
The port $B$ can be used for data bus. It is possible to refer to inside ROM or RAM through the peripheral data bus. The port $C$ becomes the control input for $A / D$ converter.

NOTE
The address bus, $R / W$ signal, and LIR signal are not available in the test mode.


Figure 6-1 Test Mode Block Diagram of the HD63L05

### 6.2 How to confirm Operation Frequency

When the E terminal of the HD63L05 is pulled up to Vcc through the resistor, 02 clock output from the OSC1 is available as output of the E terminal. The clock output from the OSC2 is available as outputs of the COM1,COM2, or COM3.

### 6.3 LCD Expansion

SEG0~SEG17,V1, and V2 terminals can be used for output terminals by mask-option. Connecting external LCD driver HD61602 to the Hd63L05, LCD driving capability of the system will be greately improved. An example of the LCD expansion is shown in Fig.6-2.

SEGO SEG7 are used for data bus to provide display data and address data (2-Byte length) to the LCD driver. A write clock for the LCD driver can be automatically obtained if the LCD1 register is used as a buffer register for the output data. When the data is written into the LCD1, the write clock for the external LCD driver is obtained on the one of the SEGMENT output terminals through the pin-location block in the MCU (same as the display data).

The LCD driver HD61602 has 4 software-controlled driving methods (Static drive, $1 / 2$ Bias $1 / 2$ Duty , $1 / 3$ Bias $1 / 3$ Duty, and $1 / 3$ Bias $1 / 4$ Duty) with 51 segment output terminals. Therefore,the LCD driving capability can be expanded up to 204 ( $51 \times 4=204$ ) segments with one external LCD driver HD61602 in case of $1 / 3$ Bias $1 / 4$ Duty Driving.


Figure 6-2 Example of LCD Expansion System

### 6.4 Method of the DAA (Decimal Adjust Accumulator)

(1) Function

This subroutine is a simulation of the DAA instruction performed by the HD63L05. This is used immediately after the addition of two bytes (ADD and $A D C$ ) whivh consist of two-digit $B C D$ (Binary Coded DEcimal) respectively. This subroutine converts the result of the $B C D$ addition into two-digit $B C D$ again and produces it to the accumulator.
(2) Linkage

The digit to be converted is input to the accumulator and operation jumps to the routine.
(Example)
LDA ARG1
ADD ARG2
JSR DAA---Jumps to the DAA subroutine
STA ARG3

Two-digit BCDs are stored in the ARG1 and ARG2 respectively and the operation jumps to the DAA after addition. The result of the addition is converted into $B C D$ and is stored in the ARG3.
(3) Result

The binary coded decimal digit is output to the accumulator.
(4) Register to be influenced
(i) IX may be guaranteed the contents before jumping to the routine.
(ii) Of the CC(Condition Code Register), the C bit is set when the result of the BCD addition or decimal conversion is rounded up. The previous contents in each bit of $\mathrm{H}, \mathrm{N}$ and Z cannot be guaranteed.
(5) Program specification

Program specification is shown in Table 6-1.

Table 6-1 Program Specification

| Number of words(B) | Work area(B) | Execution time(usec) | Reentrant | Relocation |
| :---: | :---: | :---: | :---: | :---: |
| 31 | $2 *$ | 410 | Not <br> possible*** |  |
| Intermediate interrupt |  |  |  |  |
| Possible |  |  |  |  |

[^0]

Figure 6-3 DAA Subroutine Flow Chart

Table 6-2 DAA Subroutine Program List

| ADDRESS | OP | CODE |  |  |  | COMMENT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0044 |  |  | ATEMP | RMB | 1 |  |
| 0045 |  |  | XTEMP | RMB | 1 | Work area |
| 0099 | B7 | 44* | DAA | STA | ATEMP* | Saves the input value |
| 009B | BF | 45* |  | STX | XTEMP* |  |
| 009D | 5F |  |  | CLR | X | Vacates the IX to store the |
| 009E | 25 | 04 |  | BCS | DAAH6 | converted value. |
| 00A0 | A1 | 99 |  | CMP | \#\$99 | Branches if the value is equal |
| 00A2 | 23 | 02 |  | BLS | DAALOW | to or less than \$99. |
| 00A4 | AE | 60 | DAAH6 | LDX | \#\$60 | The higher 4 bits are also converted if not so. |
| 00A6 | 29 | 06 | DAALOW | BHS | DAAL6 |  |
| 00A8 | A4 | 0F |  | AND | \# \$0F |  |
| 00AA | A1 | 09 |  | CMP | \#\$09 | It is not necessary to convert |
| 00AC | 23 | 04 |  | BLS | DAADNE | if the lower 4 bits are less than |
| O0AE | 9 F |  | DAAL6 | TXA |  | \$09.Therefore, branching is performed. |
| 00AF | AB | 06 |  | ADD | \#\$06 | The converted value of the lower |
| 00B1 | 97 |  |  | TAX |  | 4 bits. |
| 00B2 | 9F |  | DAADNE | TXA |  | Stores the converted value in A, |
| 00B3 | BB | 44* |  | ADD | ATEMP* | adds it to the original (ATEMP) |
| 00B5 | BE | 45* |  | LDX | XTEMP* | and prduces an output. |
| 00B7 | 81 |  |  | RTS |  |  |

* It is necessary to provide ATEMP and XTEMP within the stored RAM (Address $\$ 020 \sim 07 \mathrm{~F}$ ) in the work area.
6.5 Cautions on the Program of the Write Only Register and Control Register

It is not possible to change the contents of the Write Only Register (for example, the DDR Data Direction Register of the I/O port) of the HD63L05 by applying the Read/Modify/Write instructions.
(1) The Write Only Register (for example the DDR of the I/O port) cannot read, the Read/Modify/Write instructions are executed in the the following sequence.
(i) Reading the contents of the specified address
(ii) Changing the read-out data
(iii) Returning the changed data to the original address

It is clear that the Read/Modify/Write instructions cannot be applied to the Write Only Register such as DDR.
(2) For the same reason, do not set the DDR of the I/O port by using the BSET andBCLR instructions of the HD63L05.
(3) It is needed to pay attention to the System Control Register, the Timer Control Register, and the A/D Control Register when BSET,BCLR,or Read/ Modify/Write instructions are applied to them. If own interrupt request occured onto the interrupt request bit (bit7) of the Control Register between read cycle and write cycle of these instructions, the bit7 might be cleared in the write cycle and not acknowledged by CPU.
(4) Store instructions such as STA or STX are used to correctly write in the Write Only Register or to avoid missing an interrupt of the Control Register.
7. Evaluation Chip

The HD63L05E is a CMOS evaluation chip for the HD63L05. Connecting an external EPROM (HN462732) to the chip,it can be operated as a single chip microcomputer HD63L05. This chip is a 100 pins flat package. (See Figure 7-1)
7.1 B1ock Diagram

Input signals and output signals of the HD63L05E are described below. Basically, same terminal name means same function as the HD63L05.

- Vcc, Vss

Power is supplied to the LSI by using these terminals. Vcc has a voltage of $3.0 \mathrm{~V}+0.8 \mathrm{~V}$ and Vss is grounded.

INT
This terminal is used to enboke an external interruption to the LSI.

- XTAL, EXTAL

These terminals are control input terminals to the built-in clock circuit. A crystal ( 400 kHz typ.) is connected to these terminals.

- TIMER

This terminal in an external input terminal to count down the internal timer circuit.

- $\overline{\mathrm{RES}}$

Used to reset the LSI.

- STANDBY

An external input terminal used to stop the LSI and hold data.
-A/D Input Terminals (CH1~CH8)
Input terminals for analog voltages needed for $A / D$ conversion. These may also be used as level check input under program control.

- VRH, VRL

Reference voltages for $A / D$ conversion are applied to these two terminals.
-CC1, CC2
An offset compensating capacitor ( 300 pF typ.) is connected between CC1 and CC2.


Figure 7-1 Pin Assignment of the HD63L05E

XIN, XOUT
A crystal ( 32.768 kHz ) is connected to these terminals,if necessary.

- VCH

Output terminal from internal voltage regulator. A capacitor ( 0.5 uF ) is connected between VCH and Vcc.
$\overline{\text { MSET }}$
This terminal is not used for user application. Connect it to Vcc.

ADCLK
$1 / 4$ frequency of $0 S C 1$ ( 100 kHz typ. synchonized with $\phi 2$ ) is available from this terminal. NMOS open-drain output.

U/M
The HD63L05E can take two operation modes based on the state of this terminal. When the terminal is connected to Vcc,the LSI operates as a single chip microcomputer with external EPROM. However, when the terminal is grounded,the HD63L05E operates in external extension mode.

Input/Output Terminals (A0~A7, $\mathrm{B} 0 \sim \mathrm{~B} 7, \mathrm{C} 0 \sim \mathrm{C} 3$ )
These 20 terminals consist of two 8-bit ports and one 4-bit port. Each terminals may be used as an input or output under program control of the data direction register. These are NMOS open-drain output.

## D0~D7

These terminals are input terminals for instruction or data from external data bus. For example,output from an external EPROM are applied to these terminals.

- E0~E7

These terminals are NMOS open-drain outputs. When the $U / M$ is logical "1", the address bus ( $\mathrm{A} 0 \sim \mathrm{~A}$ ) from the HD63L05E is available. When the $\mathrm{U} / \mathrm{M}$ is logical " 0 ", the port $E$ can be used for address bus or data bus. When $\phi 2$ is "Low" the port E becomes address bus. When $\phi 2$ is "High" the port E becomes the peripheral data bus.

F0 F3
These terminals are NMOS open-drain outputs. When the $U / M$ is logical "1", the address bus (A8~A11) is available. When the U/M is logical "0",the port $F$ can be used for address bus while $\phi 2$ is "Low".

## - $\overline{C E} / W R$

This terminal is a NMOS open-drain output. When the $\mathrm{U} / \mathrm{M}$ is "High", chip enable signal (means address bus is in from $\$ 080$ to $\$ F F F$ ) is available. When the $\mathrm{U} / \mathrm{M}$ is "Low", Read/Write clock is available.

NMOS open-drain output. Fetch signal is available from this terminal.

- $\overline{\text { HALT }}$

NMOS open drain output. When standby signal is acknowledged,the output from this terminal becomes "Low" to control external clock source.

These are terminals for LCD driver. V1 and V2 are connected to Vcc via capacitors ( $0.1 \mu \mathrm{~F}$ each) .

- Liquid Crystal Driver Terminals (COM1~COM3, SEG1~SEG17)

COM1~COM3 are for driving common electrodes, while SEG1~SEG17 are for driving segments. SEG11~SEG17 can be used as analog inputs for A/D converter by the preset data in the EPROM.


Figure 7.-2 HD63L05E Block Diagram


Figure 7-3 HD63L05E Timing Chart
7.2 How to make a single chip microcomputer HD63L05 with the HD63L05 and EPROM

1) Power

3 V is supplied to Vcc and Vss is grounded. VCH is connected to Vcc via $0.5 \mu \mathrm{~F}$. (approximately 1 V is obtained.) V 1 is connected to Vcc via 0.1 $\mu \mathrm{F}$ and 1 V is available while V 2 is connected to vcc via $0.1 \mu \mathrm{~F}$ and 2 V is available. (See Figure 7-4)
2) $C l o c k$

The XTAL can be used for internal oscillator or input terminal from external clock source. In case of external clock, the "High" level of the clock signal should be Vcc and the "Low" level should be VCH. (See Figure 7-5)
3) Control Signals

The $\mathrm{U} / \mathrm{M}$ terminal and MSET are connected to Vcc.
4) Interfacing to the user system (See Figure 7-6)

- I/O port ( $A 0 \sim A 7, B 0 \sim B 7, C 0 \sim C 3)$

Each terminals has NMOS open-drain output. Therefore, "High" level of the output is obtained by connecting a resistor to Vcc. In case of input port, pull up the terminal to Vcc via resistor,if necessary.

- Control terminals ( $\overline{\mathrm{RES}}, \overline{\mathrm{INT}}, \mathrm{S} . \mathrm{B} ., \mathrm{TIMER}$ )

Only RESET is connected to Vcc via internal pull-up PMOS in the LSI. To avoid the floating input to INT, S.B,or TIMER, connect pull-up resistors between these terminals and Vcc,if necessary.

## - Others

SEG1~SEG17 are fixed as $1 / 3$ bias $1 / 3$ duty drive and the combination of the LCD register bit and SEG output are also fixed. This chip cannot support the modification of the pin location block in the HD63L05 and output port option. (See Table 7-1)

- A/D inputs are supported from CH1 to CH8

The selection of SEG13 SEG17 (for LCD driver or analog input CH2~CH8) can be specified by the external EPROM data. (See Table 7-2)
5) Interfacing to EPROM (See Figure 7-7)

- Data and instruction input (D0~D7)

The output terminals from the EPROM are connected to these terminals. To reduce the "High" level of the data as small as Vcc of the LSI, connect pull-down resistors to ground.

- Address Outputs (E0~E7,F0~F3)

The address bus ( $A 0 \sim$ A11) is available from these terminals for EPROM. Connect them to Vcc of the EPROM with pull-up resistors.

- Chip Select ( $\overline{\mathrm{CE}} / \mathrm{WR}$ )

Connect it to Vcc of the EPROM with pull-up resistor. When ROM address is selected (from $\$ 080$ to $\$ F F F$ ), "Low" level is available.
6) Others ( $\overline{\mathrm{HALT}}, \overline{\mathrm{LIR}}, \mathrm{ADCLK}$ )

Normally, these terminals are not used. Open them.


Figure 7-4 Connections for Power Supplying


Figure 7-5 Connections for the Oscillators


Figure 7-6 Configuration of NMOS open-drain Output


Figure 7-7 Interfacing between HD63L05E and EPROM

Table 7-1 Connections of the Pin location Block

| LCD register | Timing | SEGMENT Terminal |
| :---: | :---: | :---: |
| LCD1-0 | COM2 | SEG2 |
| 1 | COM3 | SEG2 |
| 2 | COM1 | SEG3 |
| 3 | COM1 | SEG2 |
| 4 | COM1 | SEG1 |
| 5 | COM2 | SEG1 |
| 6 | COM3 | SEG 1 |
| 7 | Not | used |
| LCD2-0 | COM2 | SEG4 |
| 1 | COM3 | SEG5 |
| 2 | COM2 | SEG5 |
| 3 | COM1 | SEG4 |
| 4 | COM2 | SEG3 |
| 5 | COM3 | SEG3 |
| 6 | COM3 | SEG4 |
| 7 | Not | used |
| LCD3-0 | COM2 | SEG6 |
| 1 | COM2 | SEG7 |
| 2 | COM1 | SEG7 |
| 3 | COM1 | SEG6 |
| 4 | COM1 | SEG5 |
| 5 | COM3 | SEG6 |
| 6 | COM3 | SEG7 |
| LCD4-0 | COM2 | SEG9 |
| 1 | COM3 | SEG9 |
| 2 | COM1 | SEG10 |
| 3 | COM1 | SEG9 |
| 4 | COM1 | SEG8 |
| 5 | COM2 | SEG8 |
| 6 | COM3 | SEG8 |
| LCD5-0 | COM2 | SEG11 |
| 1 | COM3 | SEG12 |
| 2 | COM2 | SEG12 |
| 3 | COM1 | SEG11 |
| 4 | COM2 | SEG10 |
| 5 | COM3 | SEG10 |
| 6 | COM3 | SEG11 |
| LCD6-0 | COM2 | SEG13 |
| 1 | COM2 | SEG14 |
| 2 | COM1 | SEG14 |
| 3 | C0M1 | SEG13 |
| 4 | COM1 | SEG12 |
| 5 | COM3 | SEG13 |
| 6 | COM3 | SEG14 |
| LCD7-0 | COM2 | SEG16 |
| 1 | COM3 | SEG16 |
| 2 | COM1 | SEG17 |
| 3 | COM1 | SEG16 |
| 4 | COM1 | SEG15 |
| 5 | COM2 | SEG15 |
| 6 | COM3 | SEG15 |
| LCD8-0 | COM2 | SEG17 |
| 1 | COM3 | SEG17 |
| 2 | COM2 | Not used |
| 3 | COM1 | Not used |

Table 7-2 Master-slice data in EPROM

| $\frac{\text { Bit }}{\text { Address }}$ | Data | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| \$FF0 | 0 | * | CH2 | CH3 | CH4 | CH5 | CH6 | CH7 | CH8 |
|  | 1 | * | SEG17 | SEG16 | SEG15 | SEG14 | SEG13 | SEG12 | SEG11 |
| \$FF1 | 0 | * | $\begin{aligned} & \text { OSC1 } \\ & \text { XTAL } \end{aligned}$ | * | OSC2 Not used | $\begin{aligned} & \text { OSC } 1 \\ & 0 \end{aligned}$ | Delay $1 / 16$ | $\begin{aligned} & \text { Time } \\ & 1 / 2 \end{aligned}$ | $\left\|\begin{array}{c} (\mathrm{sec}) \\ 1 \end{array}\right\|$ |
|  | 1 | * | $\begin{aligned} & \text { OSC1 } \\ & \text { CR } \end{aligned}$ | * | $\begin{aligned} & \text { OSC2 } \\ & \text { Used } \end{aligned}$ | 0 | 1/16 | 1/2 | 1 |

> * : This bit is not used
> Note that only one bit of OSC1 Delay Time select bits can be set logical "1".

### 7.3 Setting the master-slice data

The HD63L05E has two additional registers to be able to specify the master-slice data for SEG11~SEG17 (CH2~CH8) and internal oscillator mask options.

During the RES terminal is "Low", address bus(A0-A11:from Port E, Port F) become alternately $\$ F F 0$ and \$FF1. Therefore, the output data from the external EPROM(Address are $\$ F F 1$ and $\$ F F 1$ ) can be written into these registers via Port D. 3cycles are needed for writing the master-slice data into the registers.

### 7.4 Electrical Characteristics

ABSOLUTE MAXIMUM RATINGS

| Item | Symbol | Value | Unit |
| :--- | :--- | :--- | :---: |
| Supply Voltage | $\mathrm{V}_{\mathrm{CC}}$ | $-0.3 \sim+5.5$ | V |
| Input Voltage | $\mathrm{V}_{\text {in }}$ | $-0.3 \sim \mathrm{~V}_{\mathrm{CC}}+0.3$ | V |
| Output Voltage | $\mathrm{V}_{\text {out }}$ | $-0.3 \sim \mathrm{~V}_{\mathrm{CC}}+0.3$ | V |
| Operating Temparature | $\mathrm{T}_{\mathrm{Opr}}$ | $-20 \sim+75$ | ${ }^{\circ} \mathrm{C}$ |
| Storage Temparature | $\mathrm{T}_{\text {stg }}$ | $-55 \sim+125$ | ${ }^{\circ} \mathrm{C}$ |

(NOTE) Permanent LSI damage may occur if maximum ratings are exceeded. Normal operation should be under recommended operating conditions. If these conditions are exceeded,it could affect reliability of LSI.

■ELECTRICAL CHARACTERISTICS ( Vcc=3.0+0.8v,Vss=0V,Ta=-20+75 ${ }^{\circ} \mathrm{C}$, typ means typical value at $\mathrm{Vcc}=3.0 \mathrm{~V}$ unless otherwise noted.)

- DC CHARACTERISTICS

- AC CHRACTERISTICS

| Item | Symbol | Test Condition | min | typ | max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operating Clock Frequency | fcf |  | 100 | 400 | 500 | kHz |
| Cycle Time | tcyc |  | 8 | 10 | 40 | us |
| External Clock Duty | Duty |  | 45 | 50 | 55 | \% |
| Oscillation Start Time |  | $=10 \mathrm{pF}+20 \%, \mathrm{RS}=1 \mathrm{k}$ |  |  | 150 | ms |
| Oscillation Start Time | t | $=10 \mathrm{pF}+20 \%, \mathrm{RS}=20 \mathrm{k}$ |  |  | 1 | s |
| Internal Capacitance of the Oscillator |  |  |  | 10 |  | pF |
|  | ${ }_{0}$ |  |  | 10 |  | pF |
| Delay Time of Oscillation (Program) | ${ }^{\text {PLIY }}$ |  | 0 |  | 500 | ms |
| Reset Delay Time |  |  | 200 |  |  | ms |
| RES Pulse Width | ${ }_{\text {t }}^{\text {RWL }}$ |  | tcyc+1 |  |  | us |
| INT Pulse Width | ${ }^{\text {t }}$ IWL |  | tcyc+1 |  |  | us |
| TIMER Pulse Width | ${ }^{\text {TWL }}$ |  | tcyc+1 |  |  | us |

- PORT CHARACTERISTICS

| Item |  | Symbol | Test Condition | min | typ | max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output "Low" Level Voltage | Port A, B, C | $\mathrm{v}_{\mathrm{OL}}$ | $\mathrm{I}_{\text {OL }}=100 \mathrm{uA}$ |  |  | 0.3 | v |
| Input "High" Level Voltage | Port A, B, C | $\mathrm{v}_{\text {IH }}$ |  | 0.8 Vcc |  | Vcc | V |
| Input "Low" Level Voltage | Port A, B, C | $\mathrm{v}_{\text {LL }}$ |  | Vss |  | 0.2 Vcc | V |
| Input Leackage Current | Port A, B, C | $\left\|\mathrm{I}_{\text {IN }}\right\|$ | Vin=0 Vcc |  |  | 1 | $u \mathrm{~A}$ |
| Output "Low" Level Voltage | ADCLK,CE,LIR <br> HALT, Port E,F | $\mathrm{v}_{\mathrm{OL}}$ | $\mathrm{I}_{\mathrm{OL}}=200 \mathrm{uA}$ |  |  | 0.3 | V |
| Input "High" Level Voltage | Port D | $\mathrm{v}_{\mathrm{IH}}$ |  | 0.8 Vcc |  | Vcc | v |
| Input "Low" Level Voltage | Port D | $\mathrm{v}_{\mathrm{IL}}$ |  | Vss |  | 0.2 Vcc | V |

-LCD DRIVER OUTPUT CHARACTERISTICS ( $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}, \mathrm{~V}_{S S}=0 \mathrm{~V}, \mathrm{Ta}=-20+75^{\circ} \mathrm{C}$, unless otherwise noted.)

| Item |  | Symbol | Test Condition | min | typ | max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output "High" Level Voltage | Segment | $\square_{0}{ }^{\text {OH1 }}$ | $\begin{aligned} v= & 1.00 \mathrm{~V}, \mathrm{~V}=2.00 \mathrm{~V} \\ & I_{O H}=-1 \mu \mathrm{~A} \end{aligned}$ | 2.8 | , | - | V |
|  |  | VOH2 |  | 1.8 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{OH} 3}$ |  | 0.8 | - | - | V |
| Output "Low" Level Voltage | Segment | $\mathrm{V}_{\text {OL }} 1$ | $\begin{aligned} & V= 1.00 \mathrm{~V}, \mathrm{~V}=2.00 \mathrm{~S} \\ & I_{O L}=1 \mu \mathrm{~A} \end{aligned}$ | - | - | 2.2 | V |
|  |  | $\mathrm{V}_{\text {OL2 }}$ |  | - | - | 1.2 | V |
|  |  | VOL3 |  | - | - | 0.2 | V |
| Output "High" Level Voltage | Common | $\mathrm{V}_{\mathrm{OH}} 1$ | $\begin{aligned} v= & 1.00 \mathrm{~V}, \mathrm{~V}=2.00 \mathrm{~V} \\ & I_{0 H}=-5 \mu \mathrm{~A} \end{aligned}$ | 2.8 | - | - | V |
|  |  | $\mathrm{V}_{\mathrm{OH} 2}$ |  | 1.8 | - | - | V |
|  |  | $\mathrm{V}_{\text {OH3 }}$ |  | 0.8 | - | - | V |
| Output "Low" Level Voltage | Common | $\mathrm{V}_{\text {OL1 }}$ | $\begin{aligned} \mathrm{V}= & 1.00 \mathrm{~V}, \mathrm{~V}=2.00 \mathrm{~V} \\ & I_{\mathrm{OH}}=5 \mu \mathrm{~A} \end{aligned}$ | - | - | 2.2 | V |
|  |  | $\mathrm{V}_{\text {OL2 }}$ |  | - | - | 1.2 | V |
|  |  | $\mathrm{V}_{\text {OL } 3}$ |  | - | - | 0.2 | V |
| Dividing Resistor |  | $\mathrm{R}_{\mathrm{LCD}}$ | Tested between V and V | 45 | 90 | 180 | k |
| Output "High" Level Voltage | Segment | $\mathrm{V}_{\mathrm{OH}}$ | In the case of Output Port, $\mathrm{I}_{\mathrm{OH}}=-30 \mu \mathrm{~A}$ | $N_{C C}-0.3$ | - | - | V |
| Output "Low" Level Voltage | Segment | $\mathrm{V}_{\text {OL }}$ | In the case of Output Port, $I_{0 L}=30 \mu \mathrm{~A}$ | - | - | 0.3 | V |



Figure 7-8 Output Leve1 of SEG and COM


Figure 7-9 Power Supply Circuit for LCD Display

- A/D CONVERTER CHARACTERISTICS * $\left(\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}, \mathrm{~V}_{S S}=0 \mathrm{~V}, \mathrm{Ta}=-20^{\circ} \mathrm{C}+75^{\circ} \mathrm{C}, \mathrm{C}=300 \mathrm{pF}\right.$, unless otherwise noted.)

| Item |  | Symbol | Test Condition | min | typ | max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Conversion Accuracy | Resolution |  |  | - | - | 8 | bit |
|  | Absolute Accuracy |  | $\mathrm{V}_{\mathrm{RL}}=0.2 \mathrm{~V}<\mathrm{V}_{\text {in }}<\mathrm{V}_{\mathrm{RH}}=2.0 \mathrm{~V}$ | -2 | - | +2 | LSB |
| Reference Voltage | "High" Side | $\mathrm{V}_{\mathrm{RH}}$ |  | - | - | VCC | V |
|  | "Low" Side | $\mathrm{V}_{\mathrm{RL}}$ |  | $\mathrm{V}_{\text {SS }}$ | - | - | V |
|  | $\mathrm{V}_{\mathrm{RH}}-\mathrm{V}_{\mathrm{RL}}$ | $\mathrm{V}_{\text {REF }}$ |  | 2.0 | - | - | V |
|  | Input Range | $\mathrm{V}_{\text {IN }}$ |  | $\mathrm{V}_{\text {RL }}$ | - | $\mathrm{V}_{\mathrm{RH}}$ | V |
|  | Input Dynamic Range | $\mathrm{V}_{\text {DYN }}$ |  | 0.2 | - | $\mathrm{V}_{\text {CC }}-1.0$ | V |
| Ladder Resistor ( $\mathrm{VRH}^{-} \mathrm{V}_{\mathrm{RL}}$ ) |  | $\mathrm{R}_{\mathrm{HL}}$ |  | 40 | 80 | 160 | k $\Omega$ |
| Conversion Time |  | t CNV |  | 2 | - | 4 | ms |
| Programmable Voltage Comparison | Judge Error |  | $\mathrm{V}_{\mathrm{RL}}=0.2 \mathrm{~V}<\mathrm{V}_{\text {in }}<\mathrm{V}_{\mathrm{RH}}=2.0 \mathrm{~V}$ | -4 | - | +4 | LSB |
|  | Judge Time | ${ }^{\text {t CMP }}$ |  | - | - | 60 | $\mu \mathrm{s}$ |

* These value can be changed without notice, because they are provisional.


Analog Input Voltage
(When the input voltage is in the dead zone, the result of the conversion is not guaranteed.)

Figure 7-10 Dynamic Range of the Comparator


Figure 7-11 Example of 3 bit Resolution

User's programs are mask programmed into ROM by the company and are shipped as LSI. The users are requested to hand in three EPROMs in which the same contents are written,order specifications, mask option list,and list of the ROM contents.

Relationship between the address of the mask ROM and that of the EPROM is shown in Table 8-1. Write $\$$ FF for the unused address data of the EPROM.

Table 8-1 Relationship between the Address of Mask ROM and that of EPROM

| Type name | Address of Mask ROM | Address of EPROM | Remarks |
| :---: | :---: | :---: | :---: |
| HD63L05 | $\$ 080$ | $\$ 080$ <br> \$F2F | User programs are written in 'this area. |
|  | $\begin{gathered} \$ F 30 \\ \$ F F 3 \end{gathered}$ | \$F30 <br> \$FF3 | This area is used for the Self Check program by the company. |
|  | \$FF4 <br> \$FFF | \$FF4 <br> \$FFF | Vectors are written into this area. |

EPROM is a HN462732 or equivalent product.

Ordering Specifications
(1) Basic Item (Please fill in blank space or mark applicable item with symbol $\square$ )
$\left.\begin{array}{|l|l|l|ll|}\hline \begin{array}{l}\text { LSI } \\ \text { Family }\end{array} & & \text { Out Line } & \begin{array}{l}\square \mathrm{DP}-28 \\ \square \mathrm{FP}-54\end{array} & \square \mathrm{DP}-40 \square \mathrm{DP}-42 \\ \square & & \text { Remarks }\end{array}\right)$
(2) Environmental Check List

| LSI <br> Ambient <br> Temperature | nominal | ${ }^{\circ} \mathrm{C}$ | Target Level of Reliability | $\checkmark 500 \mathrm{fit} \quad \square 1000 \mathrm{fit}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | range | ${ }^{\circ} \mathrm{C}-\quad{ }^{\circ} \mathrm{C}$ |  | $\square 1$ |  |
| LSI <br> Ambient <br> Humidity | nominal | \% | Acceptable Quality Level | $\square 1.0 \%$ <br> $\square 0.4 \%$ | $\square 0.65 \%$ |
|  | range | \%- \% |  |  | $\square()$ |
| Power-ON Duration |  | hour 'day typ. | Remarks |  |  |
| Maximum Applied Voltage to LSI |  | V |  |  |  |

(3) Electrical Characteristics

| $\square$ Purchasing Specifications | $\square$ Hitachi's Standerd Specifications |
| :--- | :--- |
|  | Refer to Data Sheet |

Please fill in the space enclosed with

| ROM Code Verification |  |  |  |
| :--- | :--- | :---: | :---: |
| LSI Type No. |  |  |  |
| Shipping Date of ROM Code <br> to Customers |  |  |  |
| Approved Date of ROM <br> Code from Customers |  |  |  |

Date of Order___ Customer__
Dept.
Accepted by

Mask Option List

Select one from each item
and check $\quad$.

Date of Order
Customer
Dept.
Accepted by
ROM Code ID.
LSI Type No.
(1) Mask Option

| Item | Option | - Check | Remarks |
| :---: | :---: | :---: | :---: |
| Selection of Oscillatorl | Crystal | $\square$ OSCX |  |
|  | Resistor | - OSCR |  |
| Selection of Oscillator | With 32.768 kHz Crystal | $\square$ Yes |  |
|  |  | - No | 1/3 of cycle clock is provided |
| Delay time of OSC1 | No Delay time | $\square$ No. |  |
|  | 1/256 seconds | $\square$ Yes |  |
|  | 1/16 seconds | $\square$ Yes |  |
|  | 1/2 seconds | $\square$ Yes |  |
| Configuration of SEG1~SEG17 | Segment ${ }^{\text {Static }}$ | $\square \mathrm{Yes}$ |  |
|  | $\begin{aligned} & 1 / 3 \text { Bias } \\ & 1 / 3 \text { Duty } \\ & \hline \end{aligned}$ | $\square$ Yes |  |
|  | Output Port | $\square$ Yes |  |

(2) I/O Option

| PIN | I /0 | Mask Option |  |  |  |  |  | Remarks | Pin | I/0 | Mask Option |  |  |  | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | A | B | C | D | E | F |  |  |  | G | H | J | K |  |
| A0 | I/0 |  |  |  |  | * | * |  | SEG1 | 0 | * |  |  | * |  |
| A1 | I/0 |  |  |  |  | * | * |  | SEG2 | 0 | * |  |  | * |  |
| A2 | I/0 |  |  |  |  | * | * |  | SEG3 | 0 | * |  |  | * |  |
| A3 | I/0 |  |  |  |  | * | * |  | SEG4 | 0 | * |  |  | * |  |
| A4 | I/0 |  |  |  |  | * | * |  | SEG5 | 0 | * |  |  | * |  |
| A5 | I/0 |  |  |  |  | * | * |  | SEG6 | 0 | * |  |  | * |  |
| A6 | I/0 |  |  |  |  | * | * |  | SEG7 | 0 | * |  |  | * |  |
| A7 | I/0 |  |  |  |  | * | * |  | SEG8 | 0 | * |  |  | * |  |
| B0 | I/0 |  |  |  |  | * | * |  | SEG9 | 0 | * |  |  | * |  |
| B1 | I/0 |  |  |  |  | * | * |  | SEG10 | 0 | * |  |  | * |  |
| B2 | I/0 |  |  |  |  | * | * |  | SEG11 | 0 | * |  |  | * |  |
| B3 | I/0 |  |  |  |  | * | * |  | SEG12 | 0 | * |  |  | * |  |
| B4 | I/0 |  |  |  |  | * | * |  | SEG13/CH6 | I/0 |  |  |  | * |  |
| B5 | I/0 |  |  |  |  | * | * |  | SEG14/CH5 | I/0 |  |  |  | * |  |
| B6 | I/0 |  |  |  |  | * | * |  | SEG15/CH4 | I/0 |  |  |  | * |  |
| B7 | I/0 |  |  |  |  | * | * |  | SEG16/CH3 | I/0 |  |  |  | * |  |
| C0 | I/0 |  |  |  |  | * | * |  | SEG17/CH2 | I/0 |  |  |  | * |  |
| C1 | I/0 |  |  |  |  | * | * |  | V1/CH7 | I/0 |  | * |  |  |  |
| C2 | I/0 |  |  |  |  | * | * |  | V2/CH8 | I/0 |  | * |  |  |  |
| C3 | I/0 |  |  |  |  | * | * |  |  |  |  |  |  |  |  |
| $\overline{\text { INT }}$ | I | * | * | * | * |  |  |  |  |  |  |  |  |  |  |

## Note

A : CMOS Output without Input pull-up PMOS
B : CMOS Output with Input pull-up PMOS
C : CMOS Output for Key scanning
D : NMOS Open-drain Output
E : Input without pull-up PMOS
F : Input with pull-up PMOS
G : A/D Input
H : Segment Output
J : Port Output (SEGl~SEG17, V1, and V2)
K : Terminals for LCD Display
(3) LCD Pin Location


## Note

Select Display Timing and SEGMENT
Terminal for each bit of LCD1~LCD8.

In case of Static Driving or Output
Port, the Timing
is fixed at COM1.
\$WRITE Clock is
generated when
data is written into the LCD1.

6-2. Otemachi 2-Chome, Chiyoda-ku

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[^0]:    *: It is necessary to provide this work area within the stored RAM (\$020 \$07F).
    **: Depending on the situation,it may be necessary to mask the interrupt during the execution of this subroutine.

